



Optical 3D - Inspection of Laser Induced Micro Structures

**Dr. Josef Frohn
NanoFocus AG
Oberhausen, Ettlingen**

founded in 1994

**optical surface inspection:
development & production of
3D laser profilometer μ scan[®] &
3D confocal microscope μ surf[®]**

**main markets:
automotive, micro technology,
medical, forensic, electronics,
printig, solar**

> 700 installed systems



**NanoFocus AG
HQ
Oberhausen
Germany**



**NanoFocus Sales
Ettlingen - Munich
Germany**

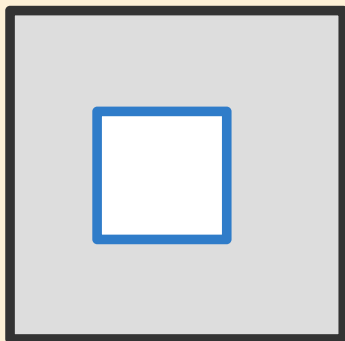
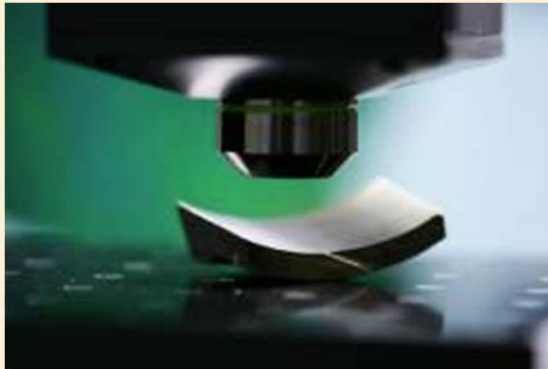


**NanoFocus Inc.
Glen Allen, VA
USA**

**NF Pte. Ltd.
Singapore**

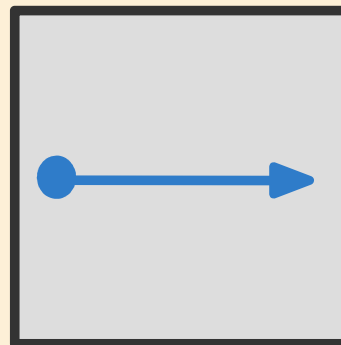
Product Categories

μsurf® 3D-Microscopy



- 3D-Structure
- Wear
- Tribology

μscan® 2D-Profilometry

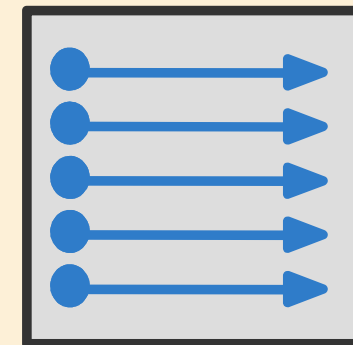


- 2D-Shape
- Roughness

μsprint® 3D-Profilometry

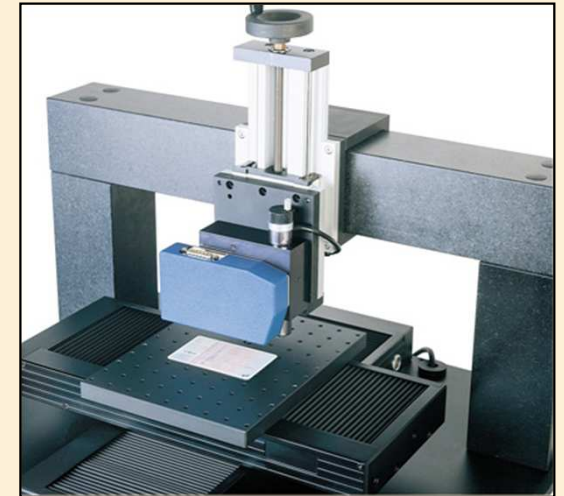
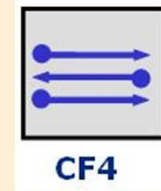
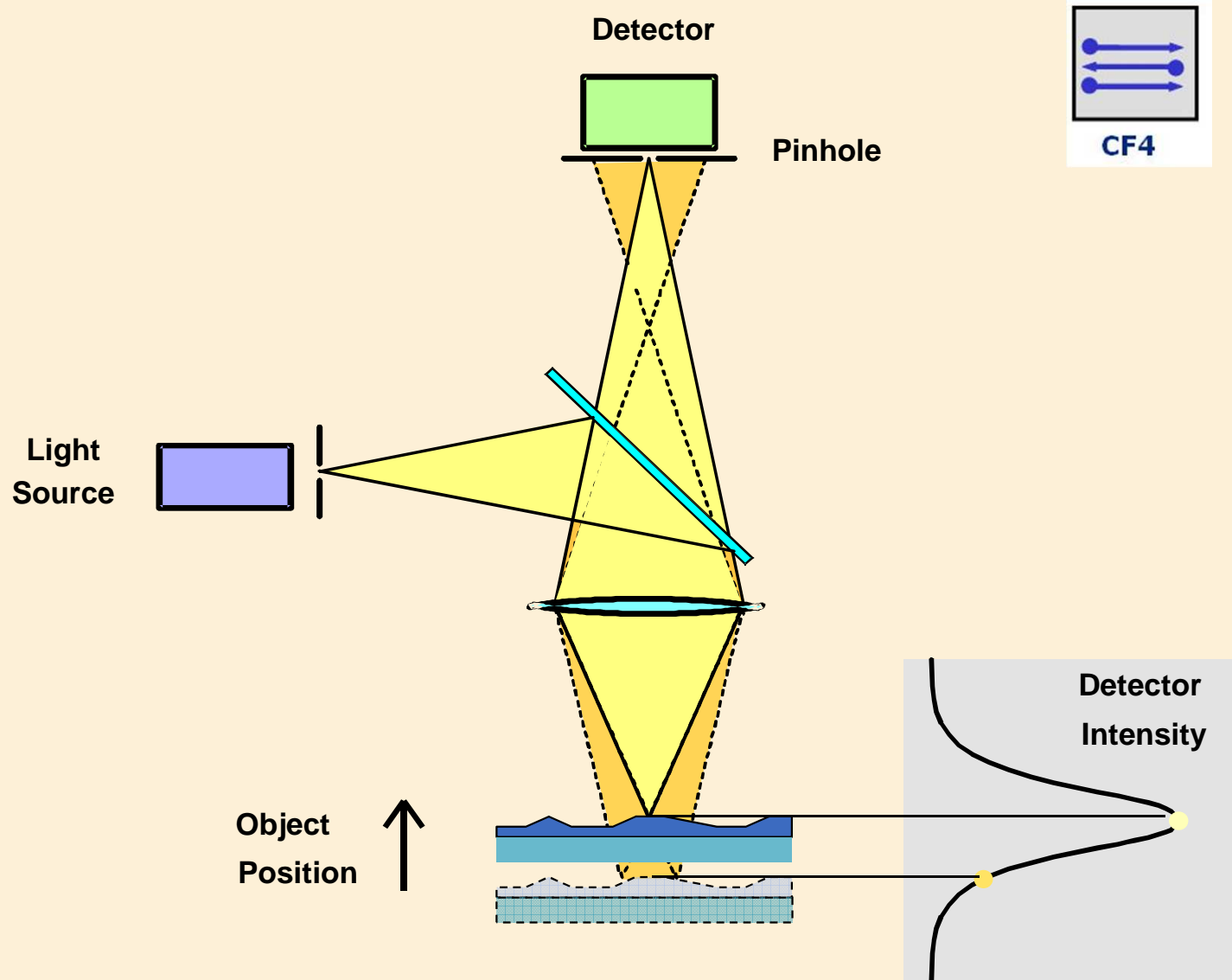


NEW

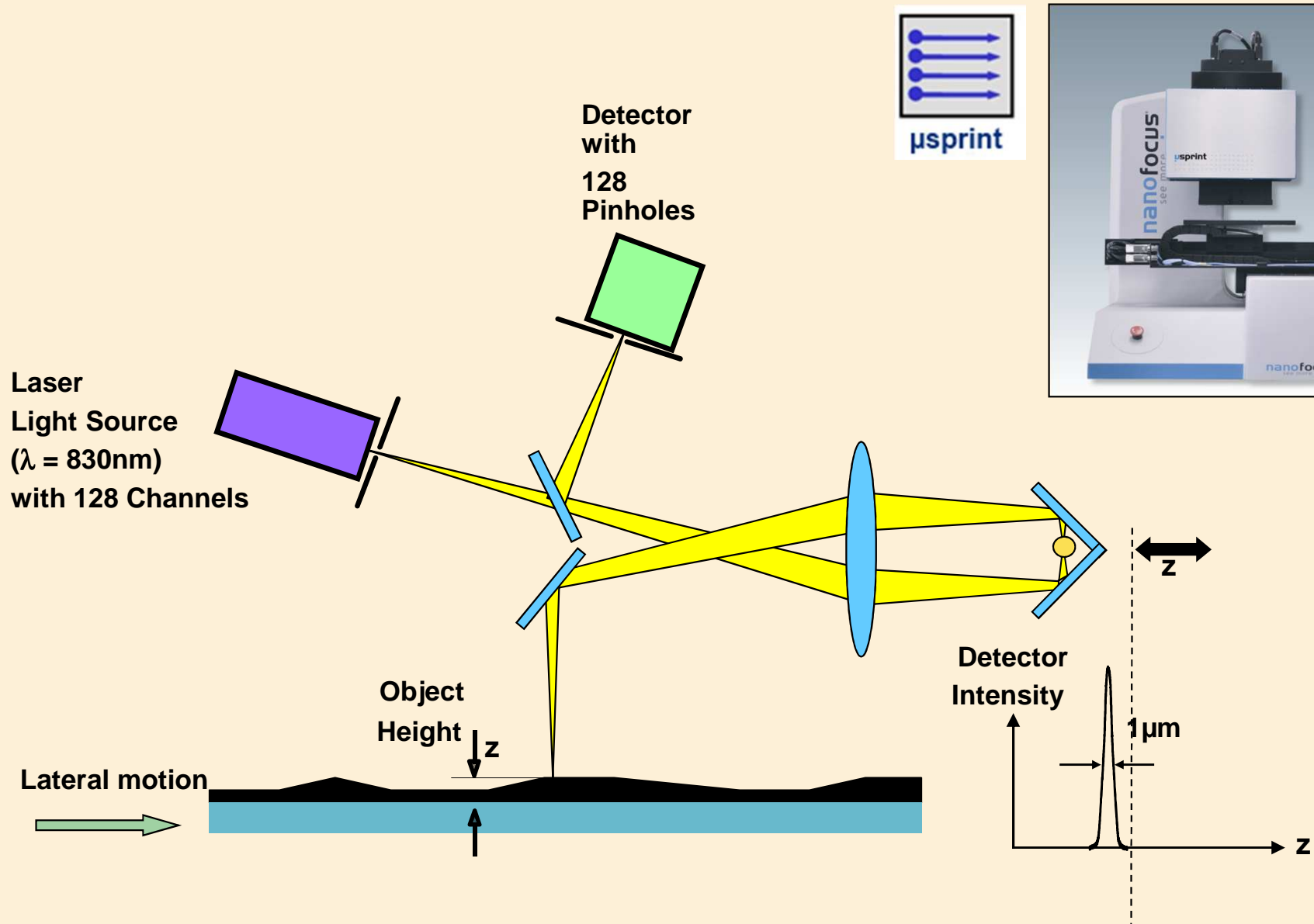


- 3D-Shape
- Defects
- Production Control

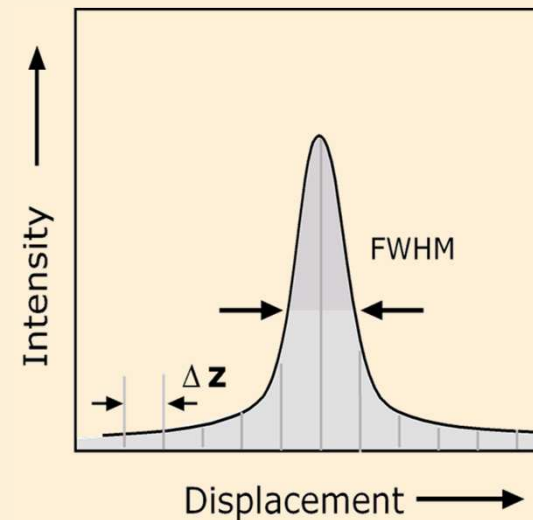
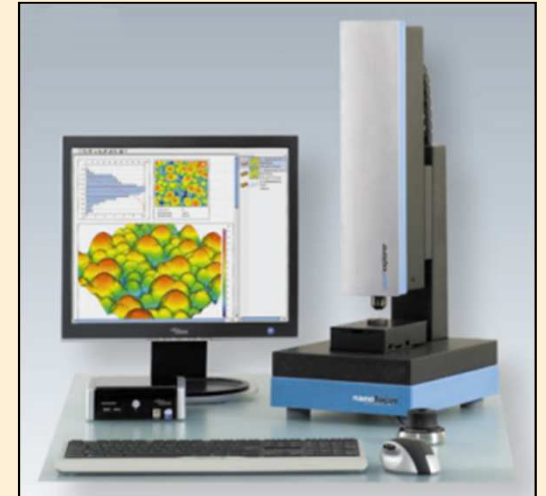
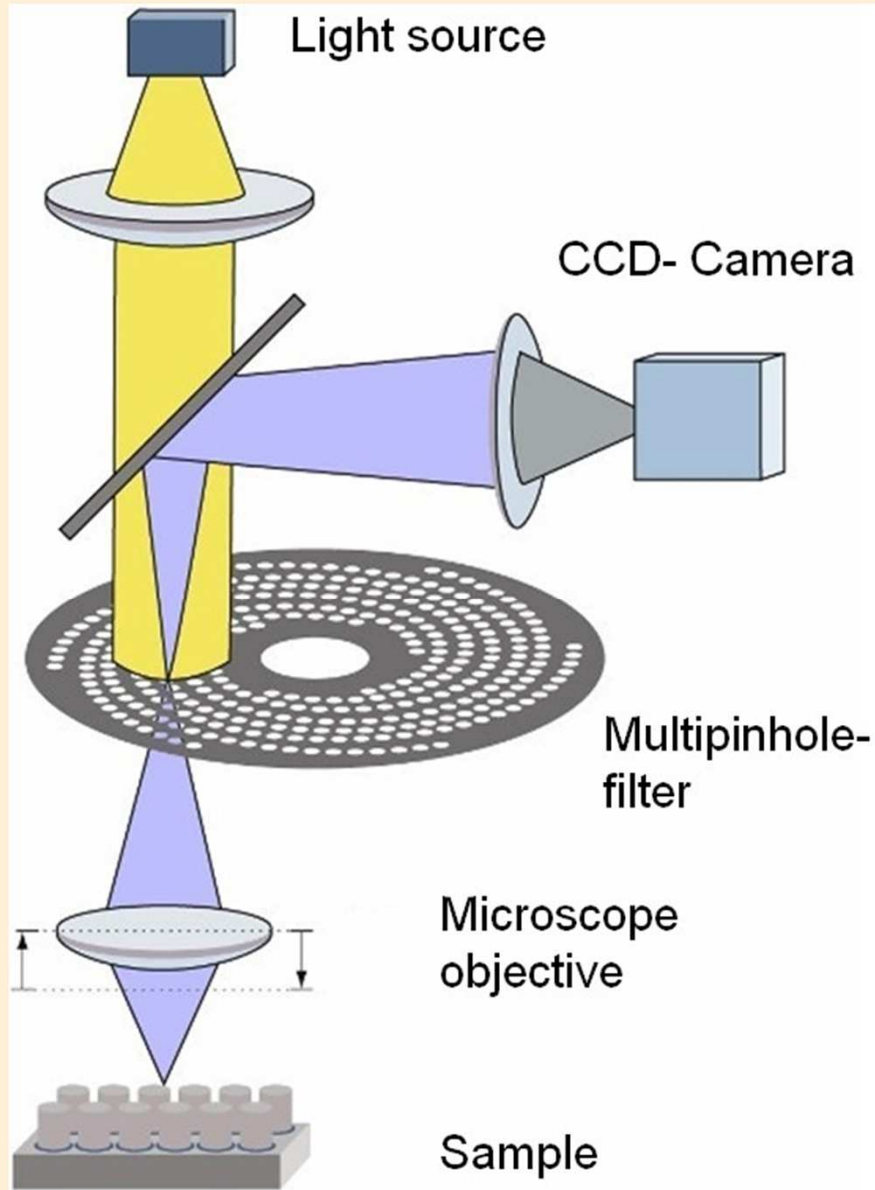
Confocal Principle



μsprint Technology

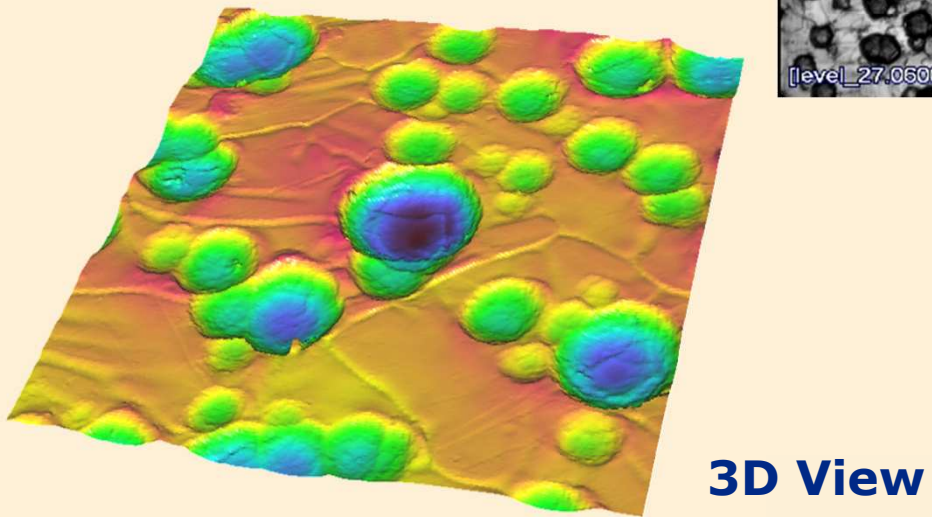
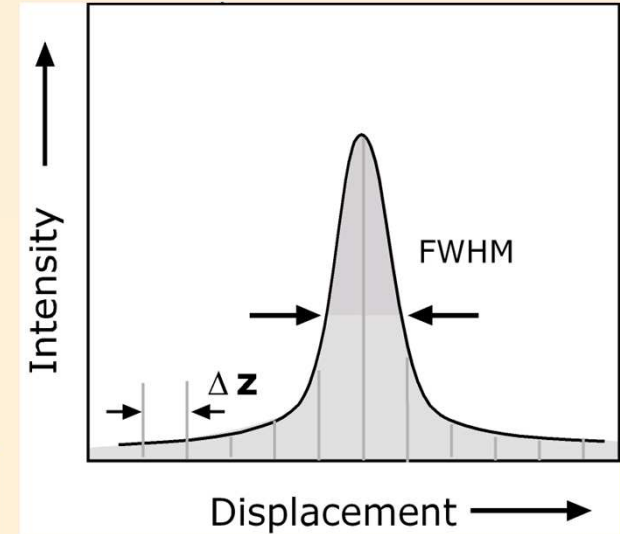
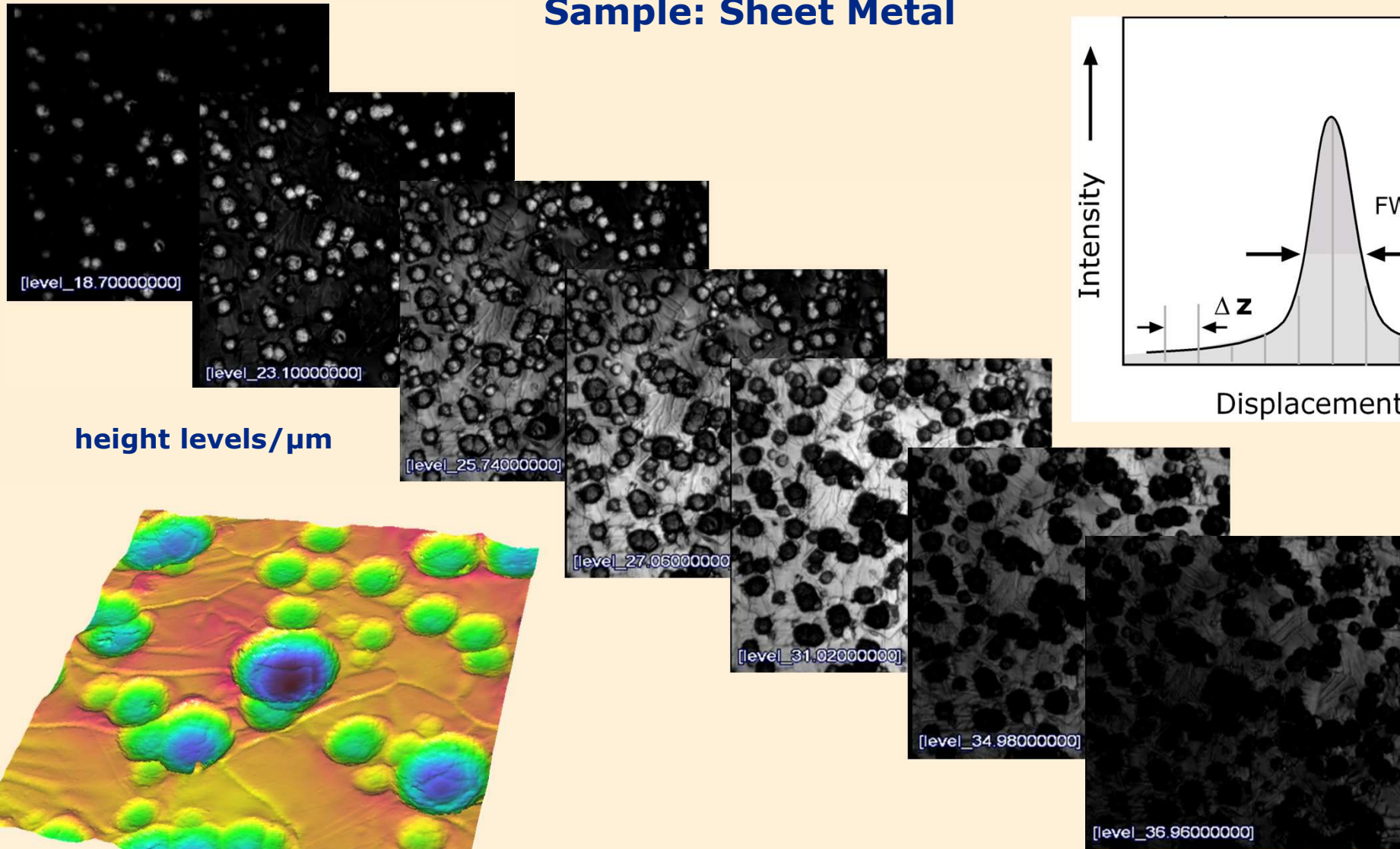


μsurf Technology

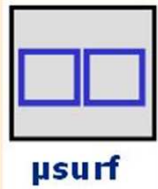
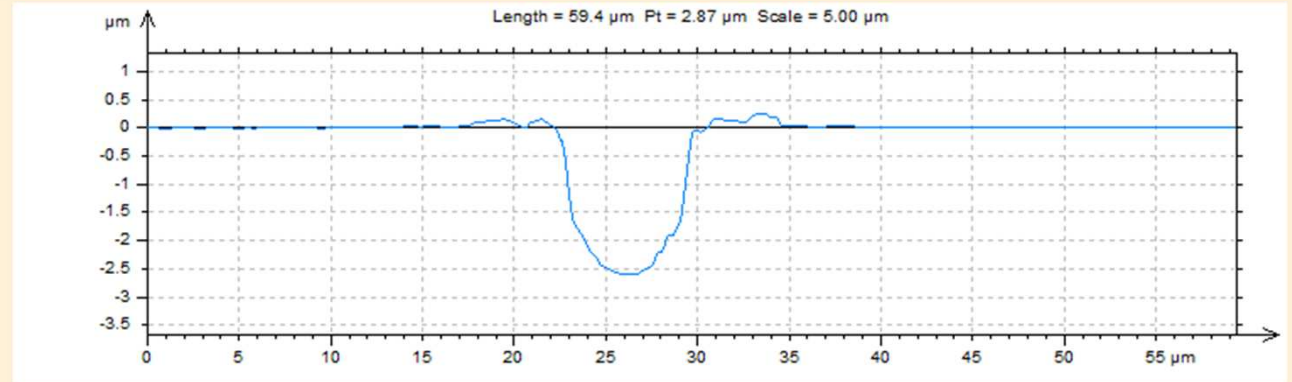
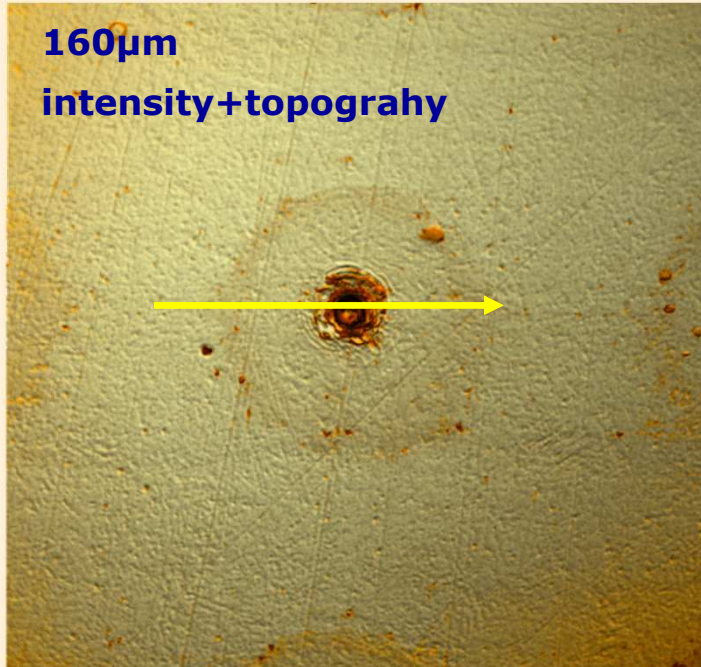


Confocal Imaging Sequence

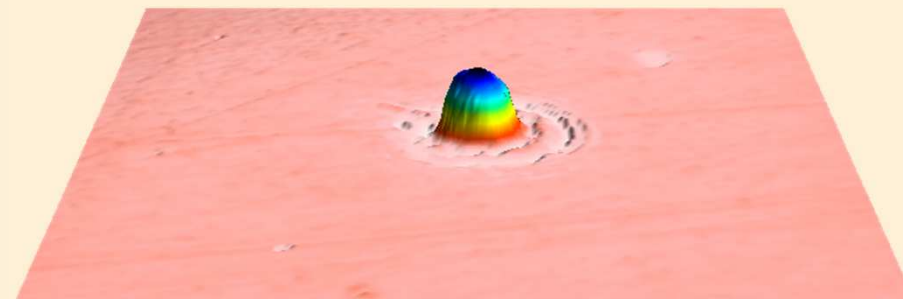
Sample: Sheet Metal



Example Laser Marking

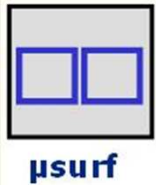
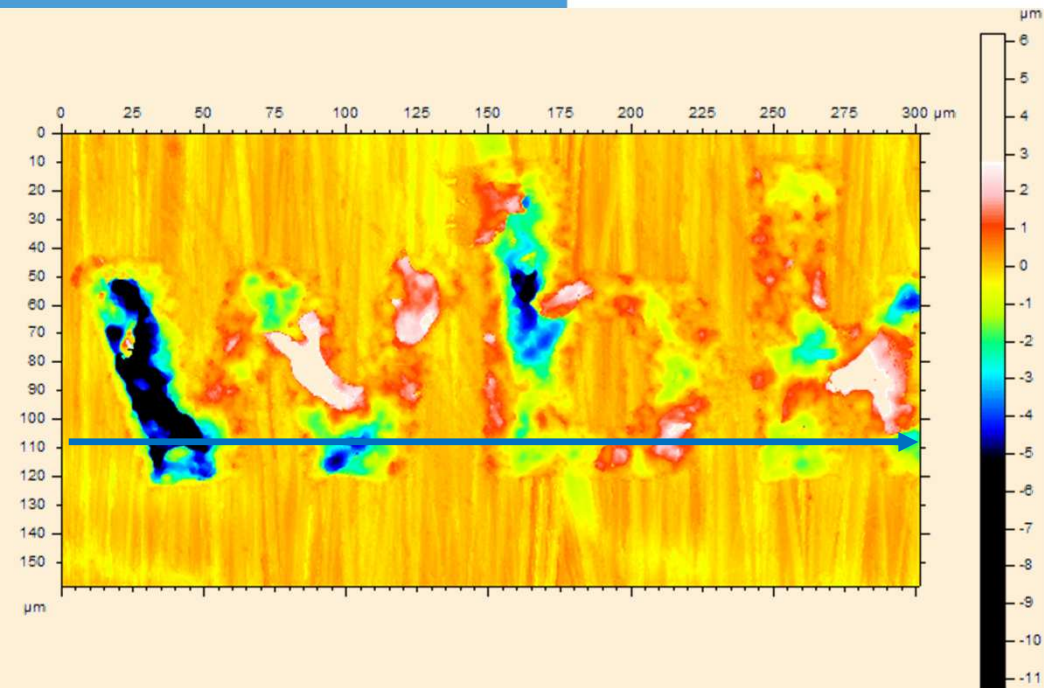
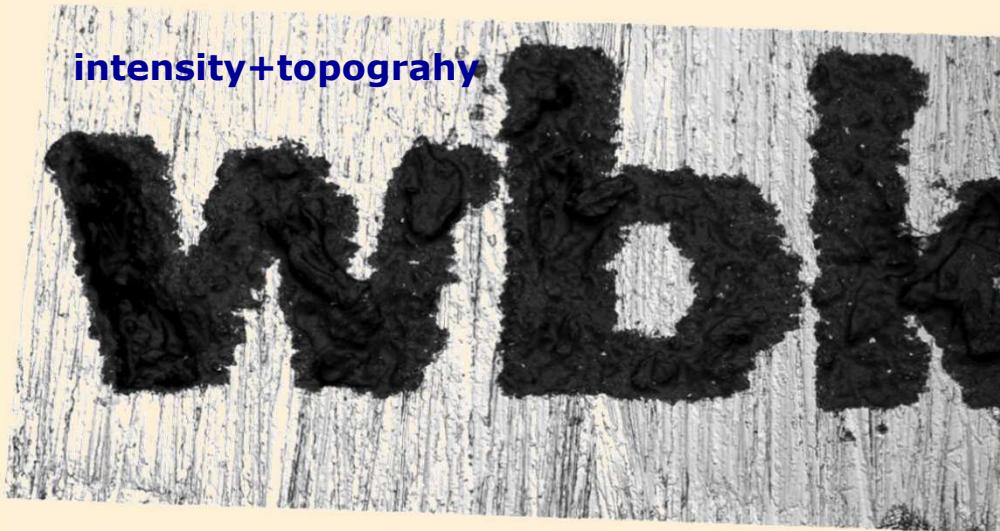


3f NdYAG 355nm
3-4µm focus diameter
steel

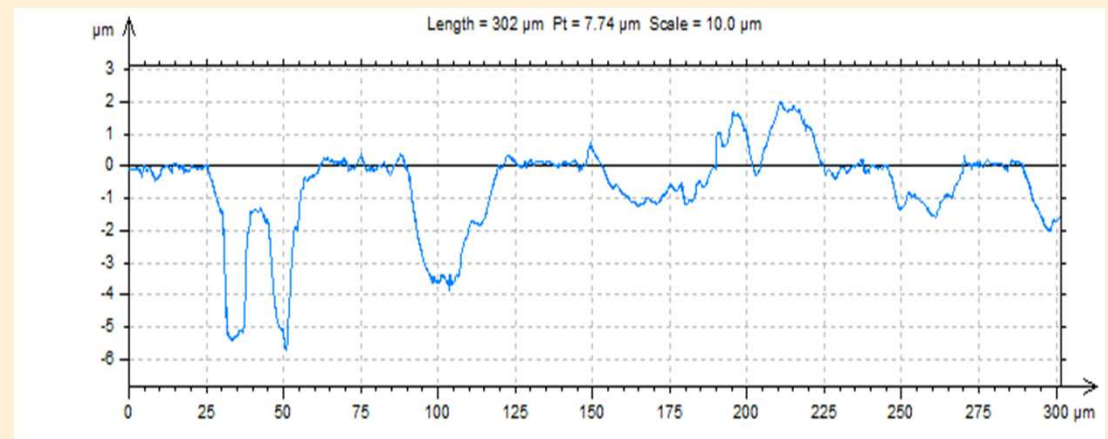


70µm, inverted

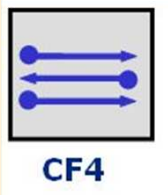
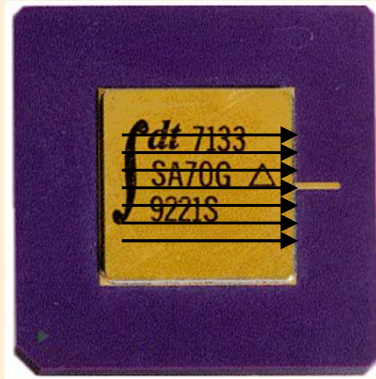
Example Laser Marking



3f NdYAG 355nm
3-4μm focus diameter
steel

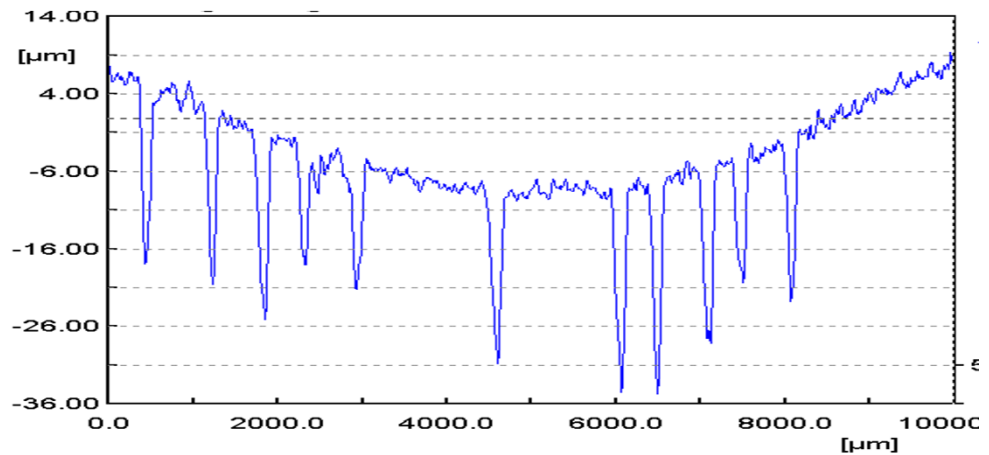
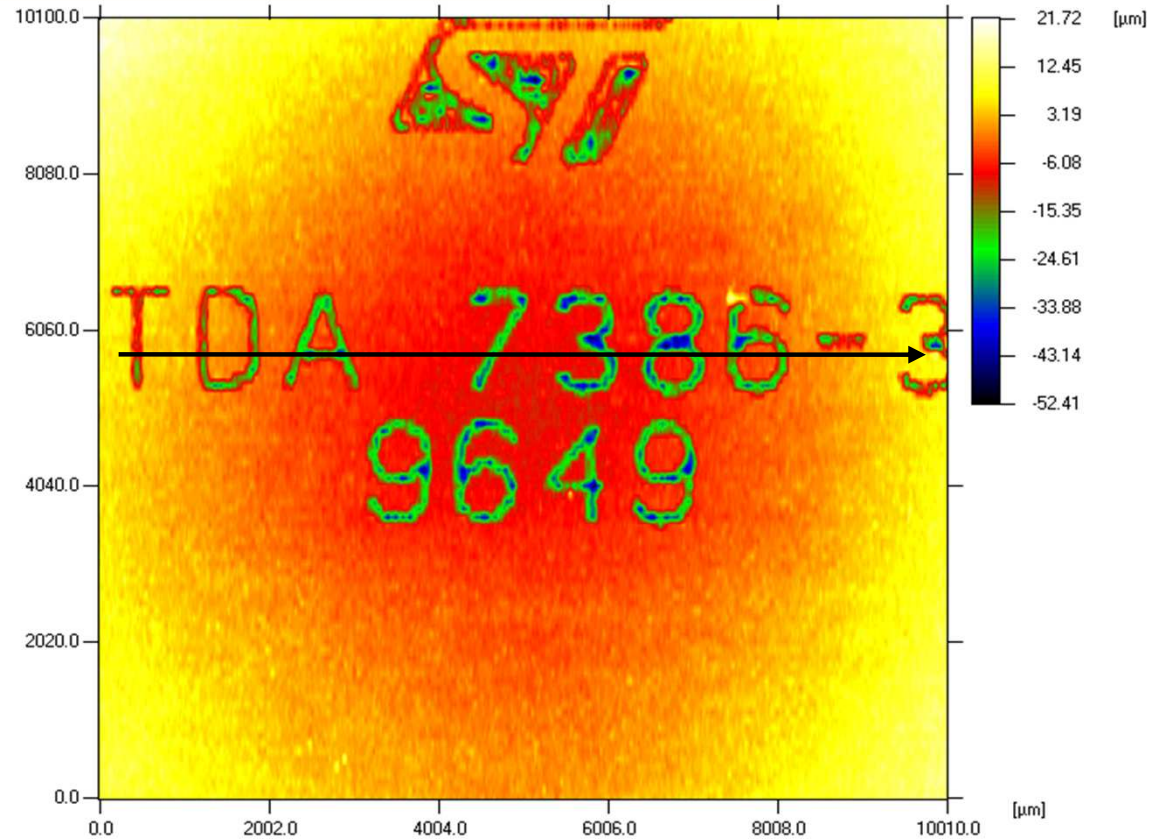


Example Laser Marking

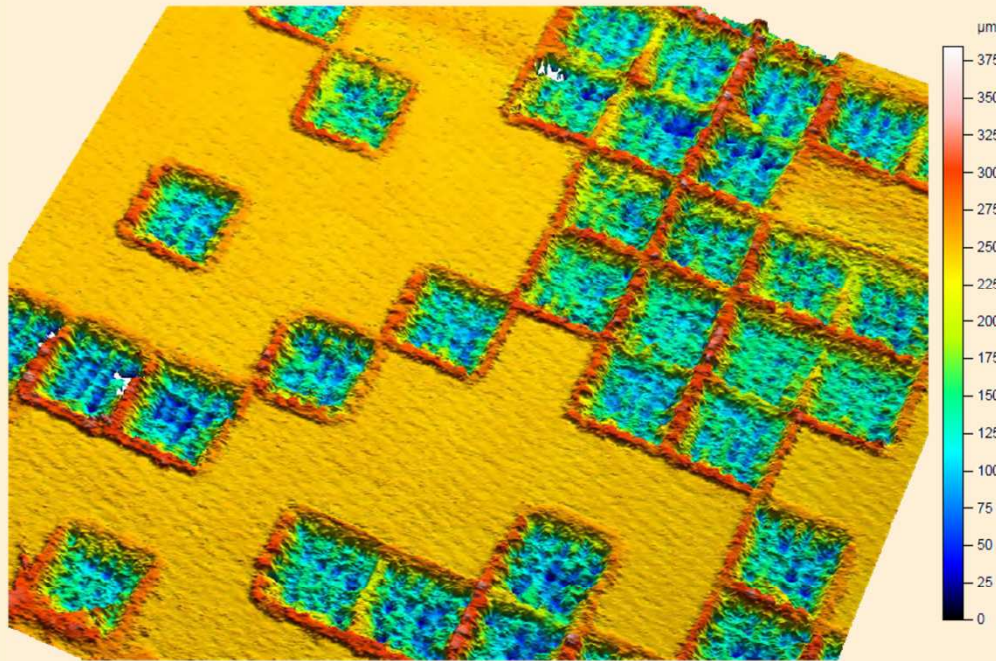


Warpage

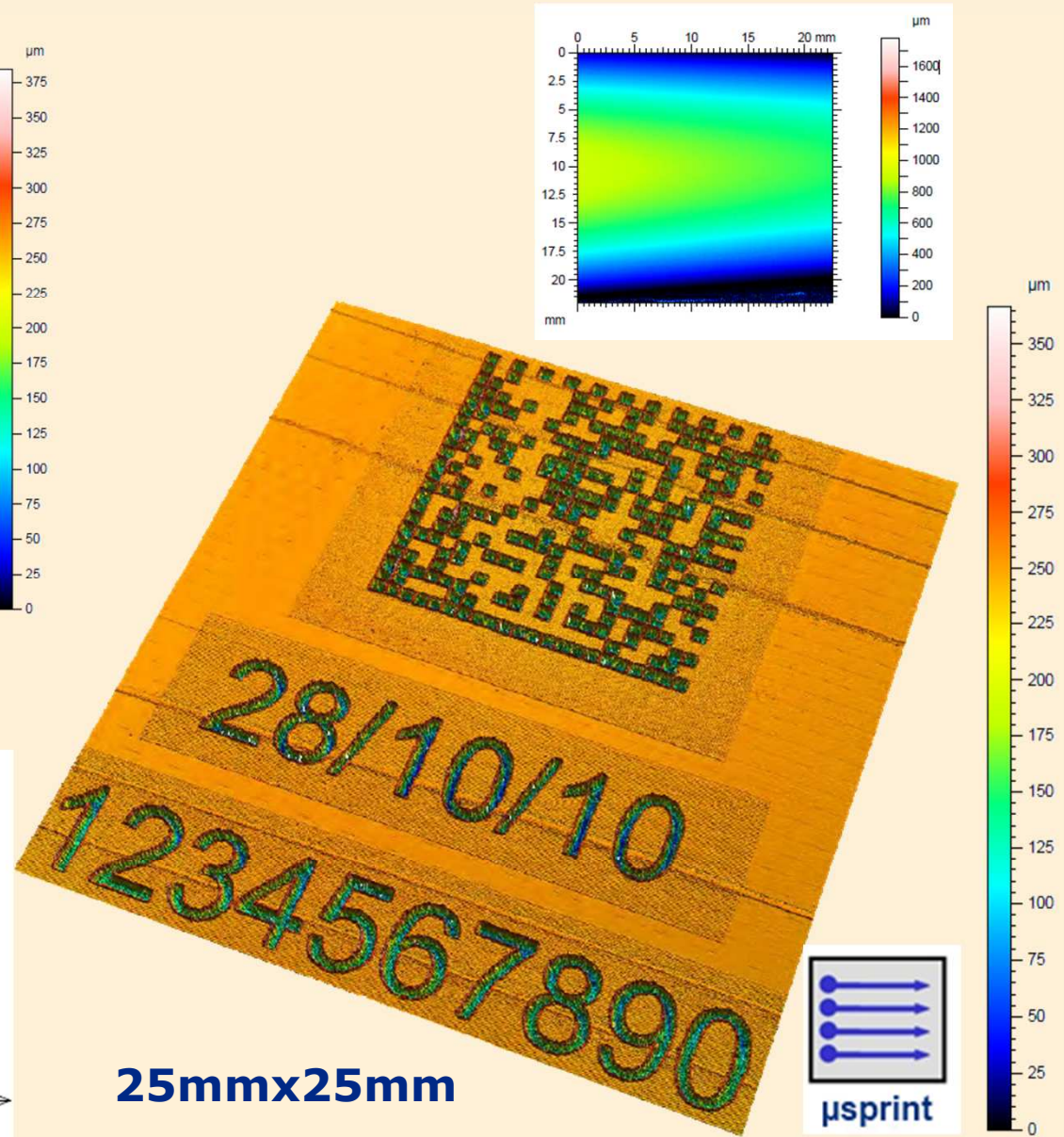
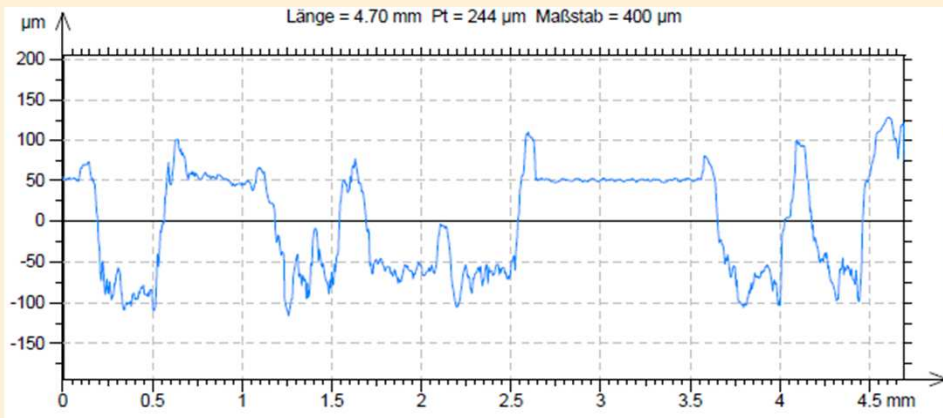
**Lasermarking
Profile**



Example Laser Marking



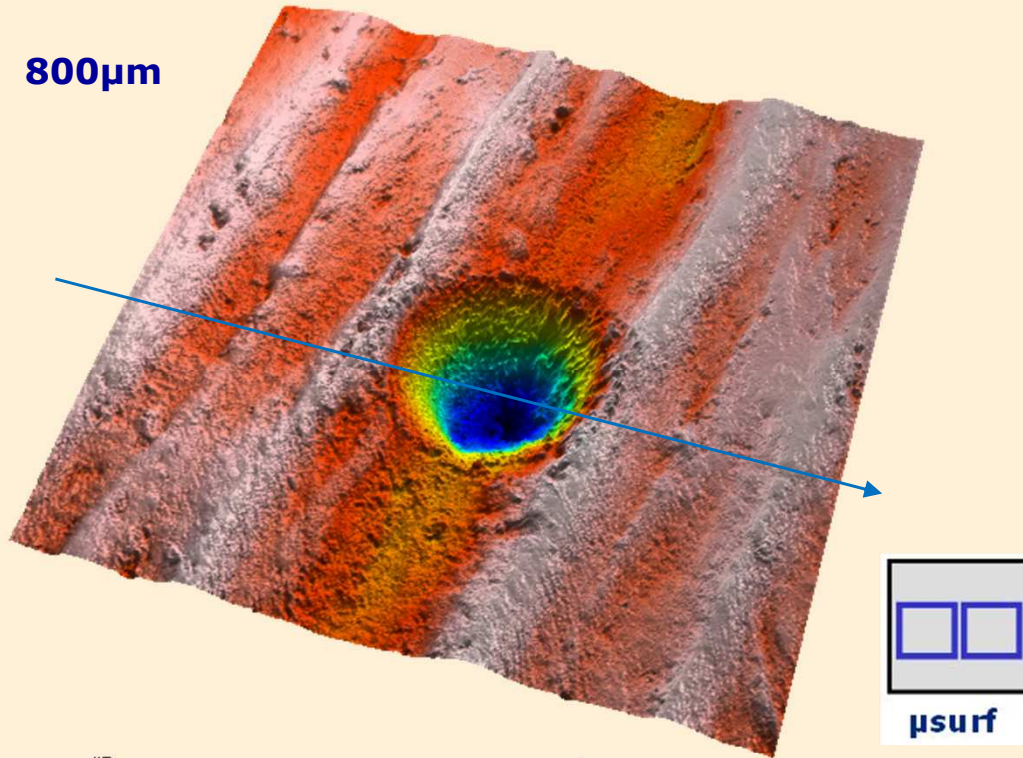
5mmx5mm



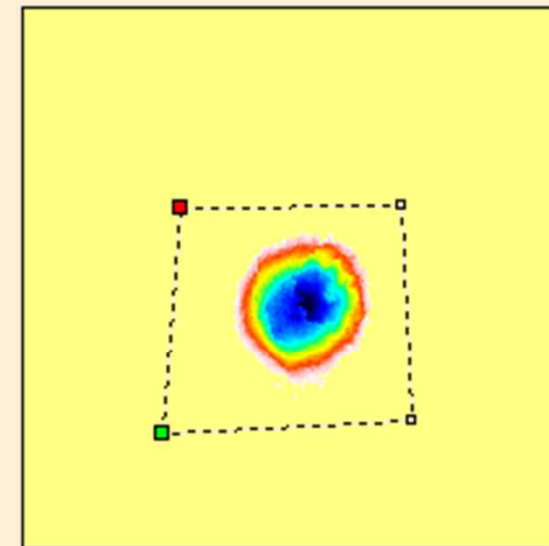
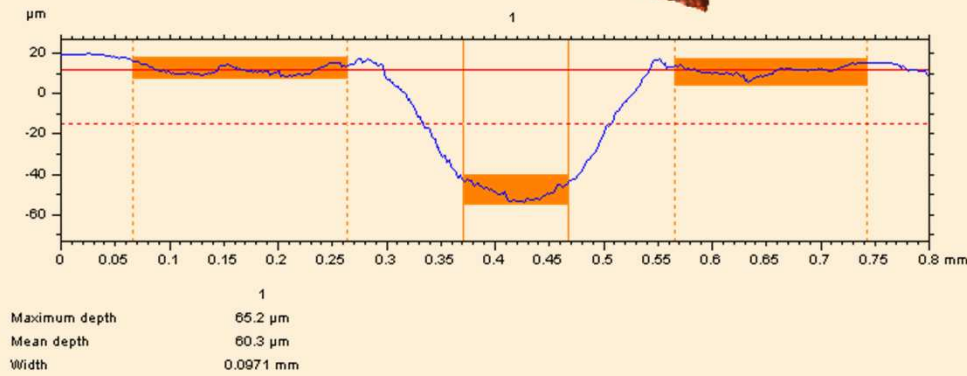
25mmx25mm

Laser Ablation of Bone Material

800µm

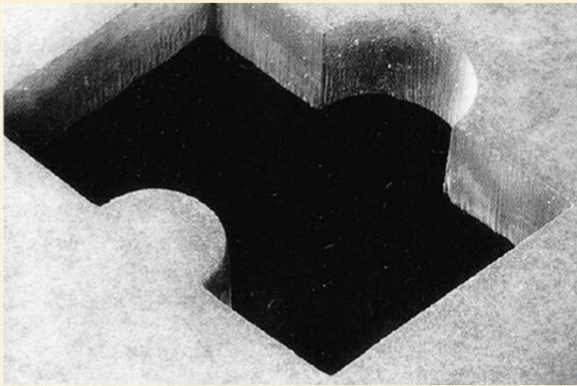


process evaluation by
depth and volume
evaluation



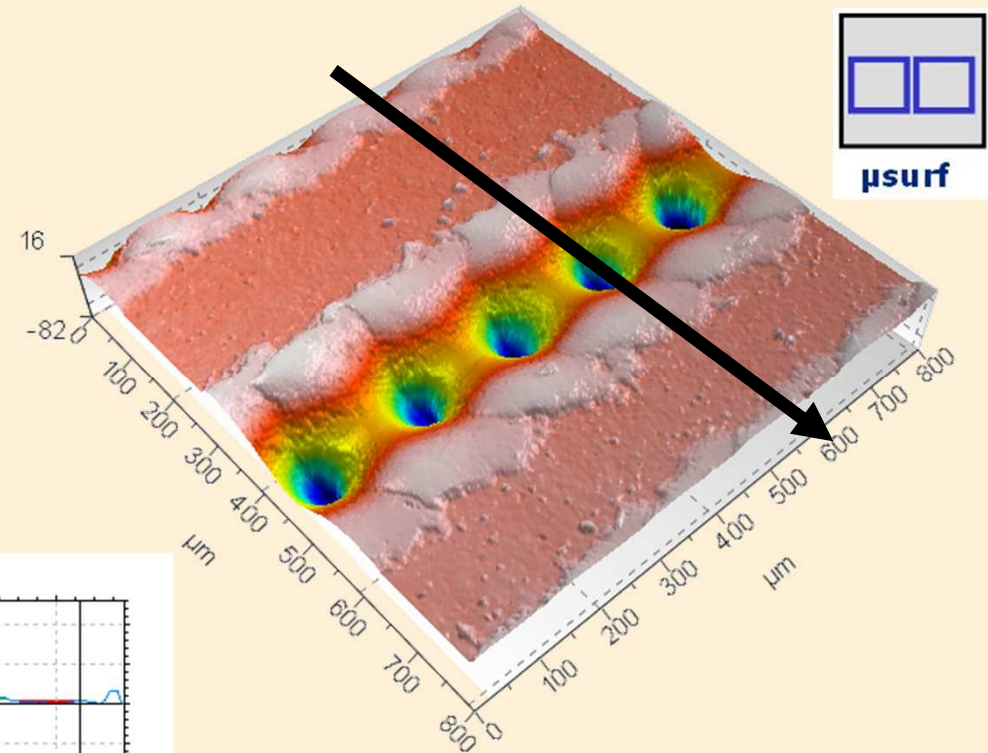
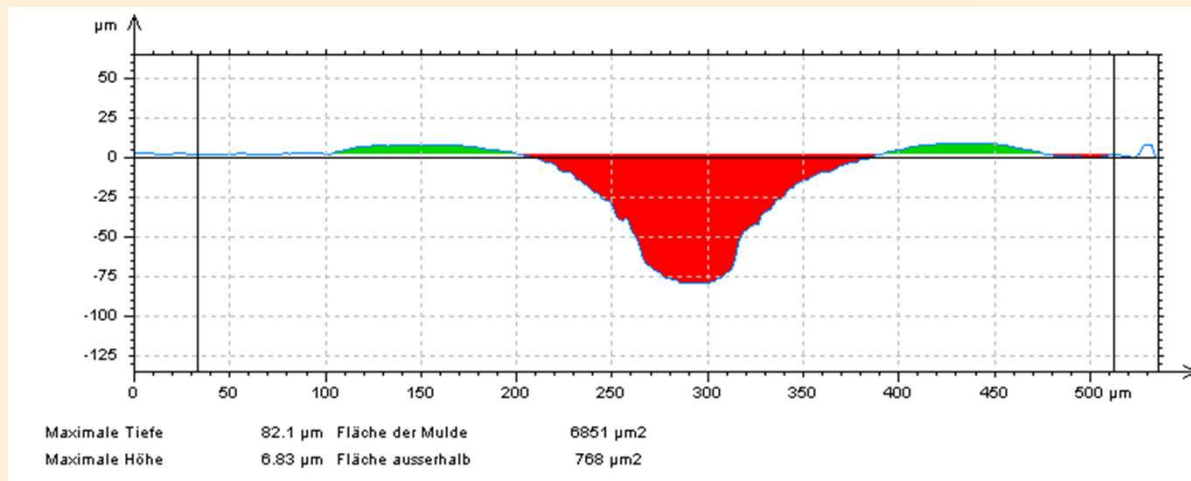
Volume (µm ³)	Hole	757608
Max. depth/height (µm)		51

Laser Ablation of Ceramics



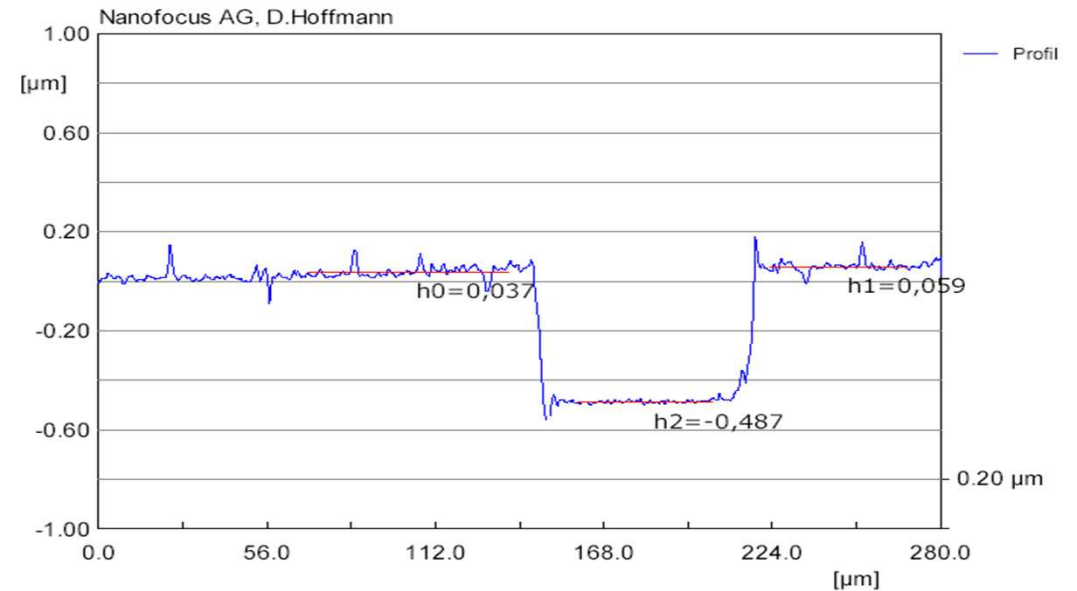
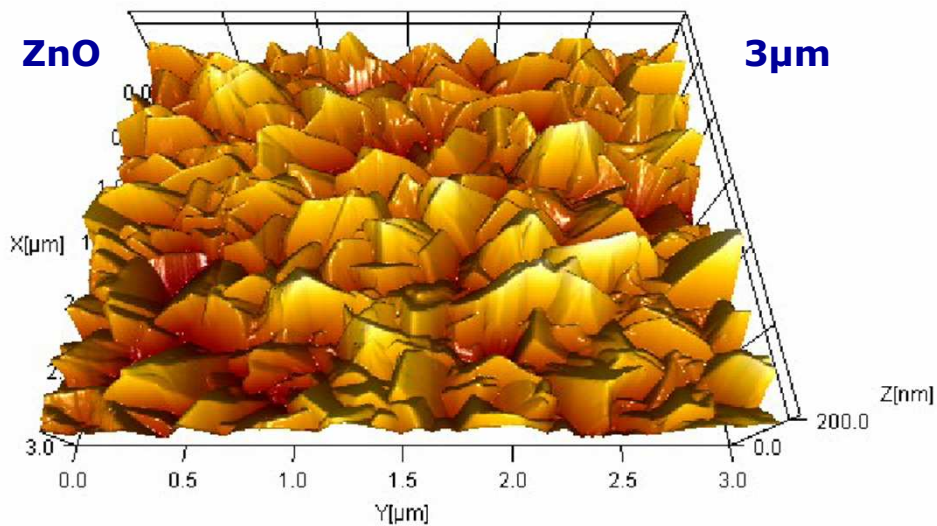
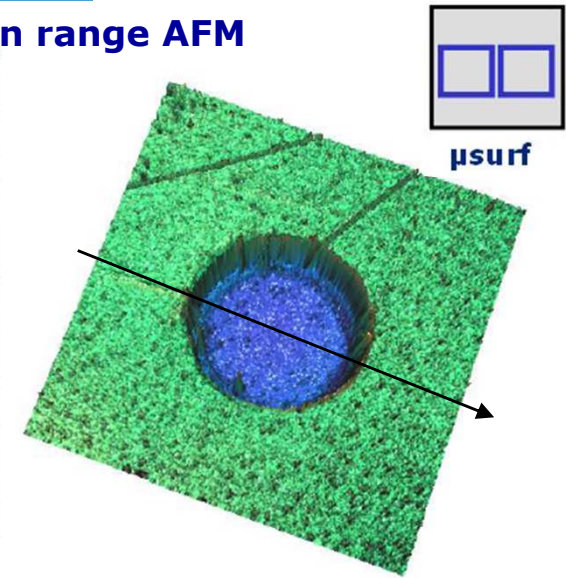
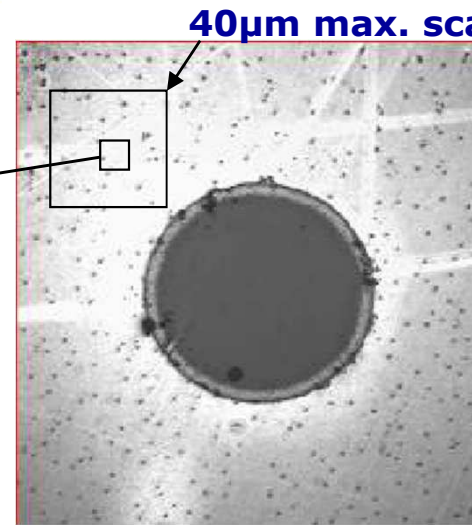
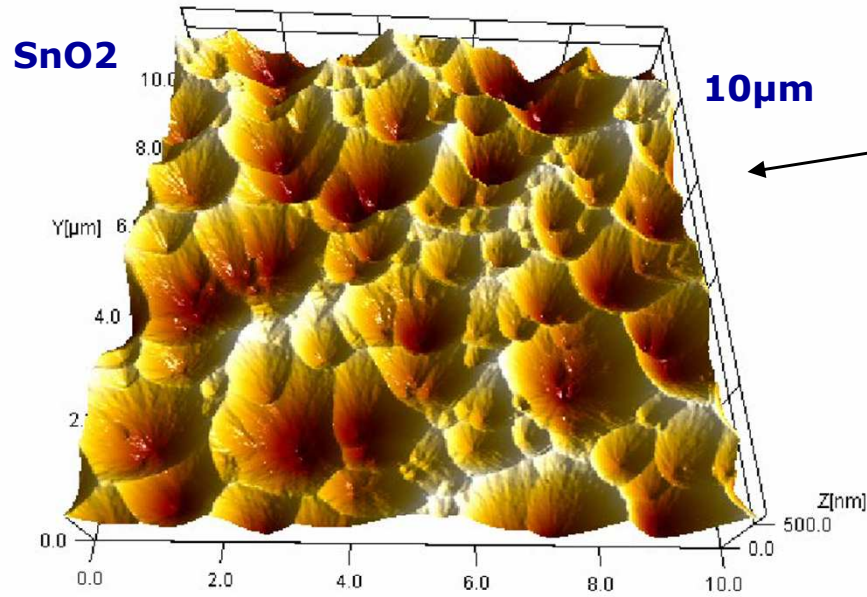
Quelle: LPKF.de

profile analysis



**height measurement and
melt area characterisation**

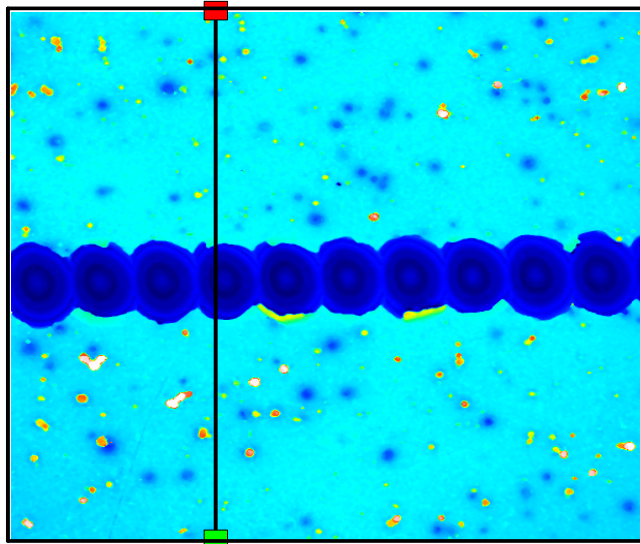
Solar Cells (FZJ-IPV)



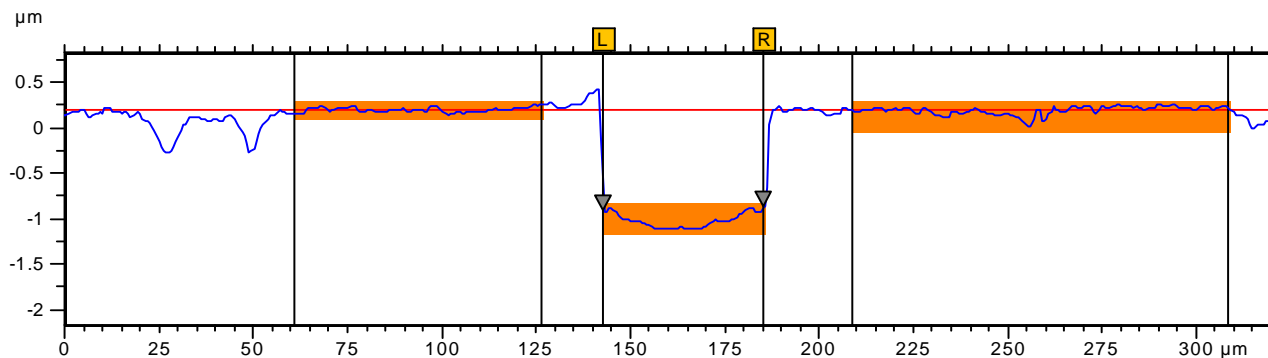
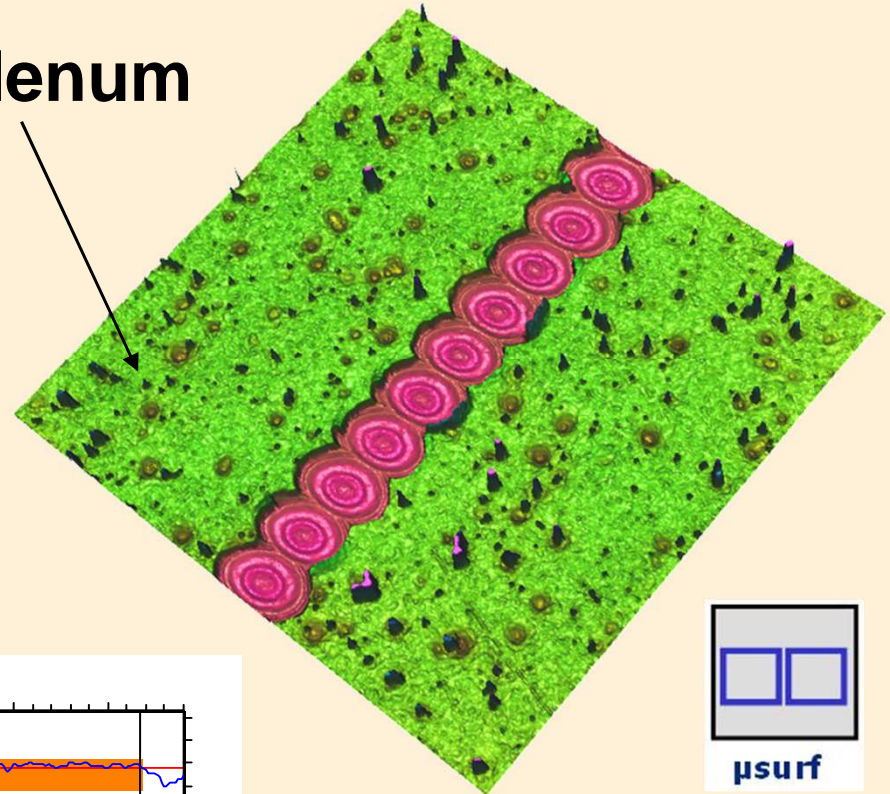
Thin-Film: Laser Scribes on Mo

Molybdenum

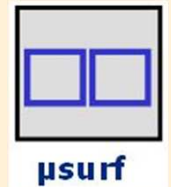
**quality
assurance of
laser texture**



Extracted profile

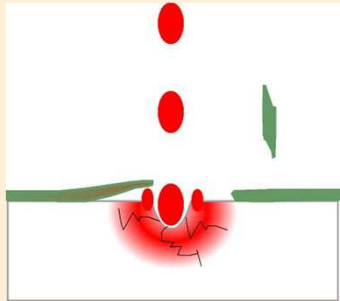


	1
Maximum height	1.31 µm
Mean height	1.21 µm
Width	43.2 µm

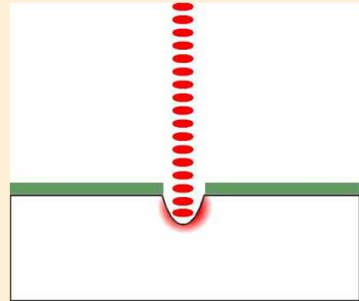


320S

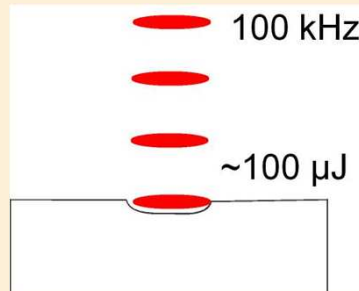
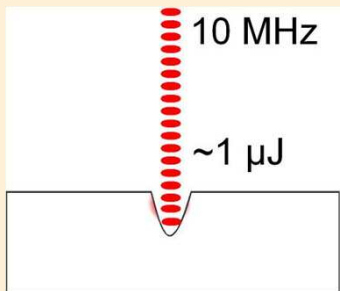
Laser Direct Patterning



Nano second



Ultra short



Traditional way to process thin films

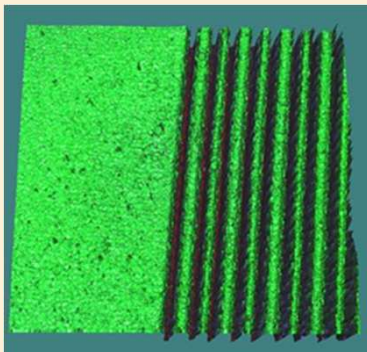
- Lithographical process
- Typical Multi step process
 - High investment cost
 - Masks required
 - Inflexible
 - Chemicals required

Laser assisted patterning process

- Typical 1-2 step process
- Lower investment cost
- No masks required, Flexible
- No chemicals required

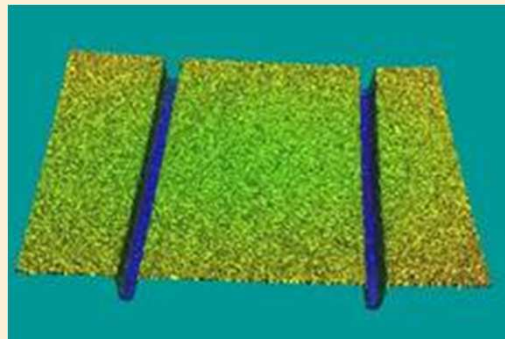
ITO on Glass

- Groove depth: 0.25 μ m
- Groove width: \sim 8 μ m



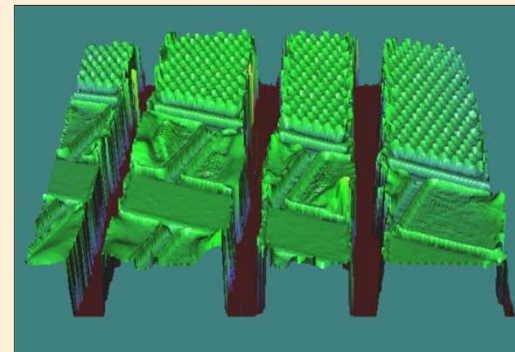
SnO on Polymer

- Groove depth: 0.6 μ m
- Groove width: \sim 12 μ m

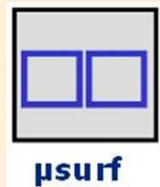
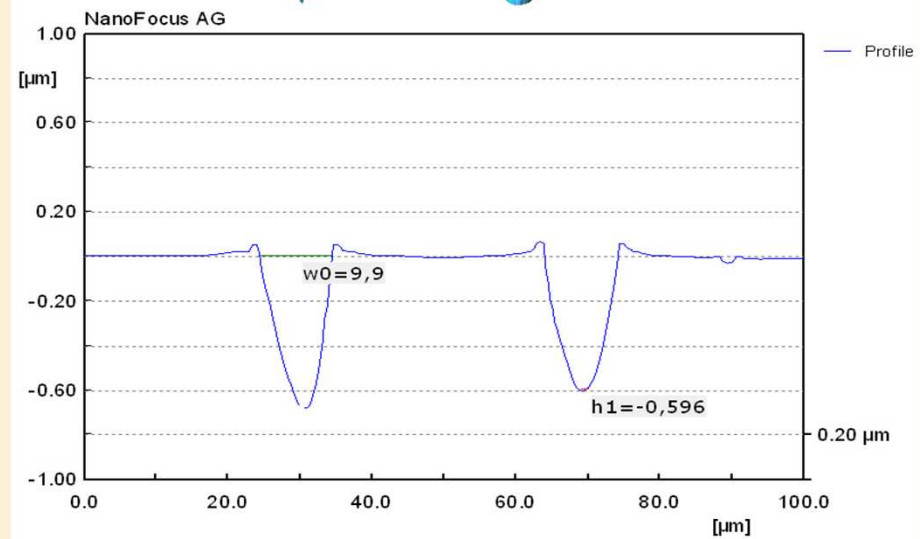
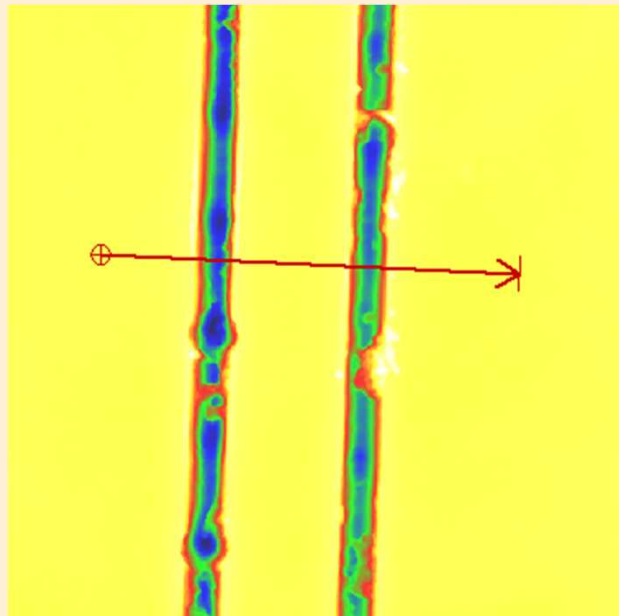
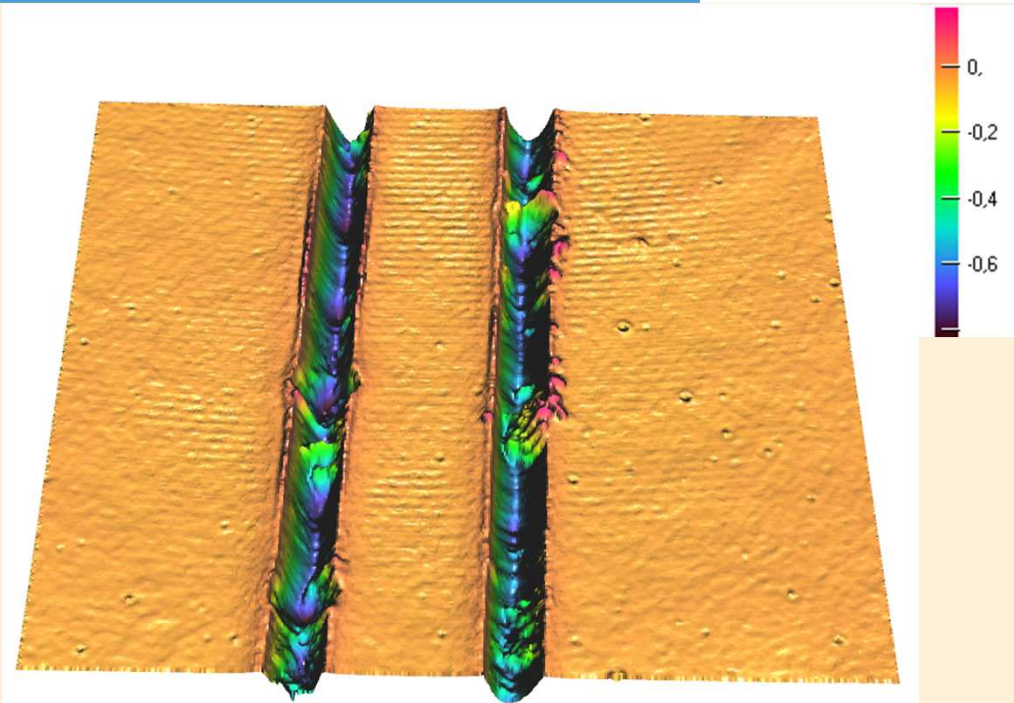
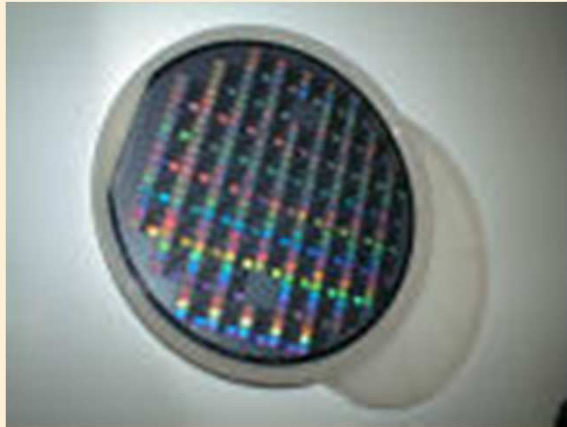


low-k + Al pads

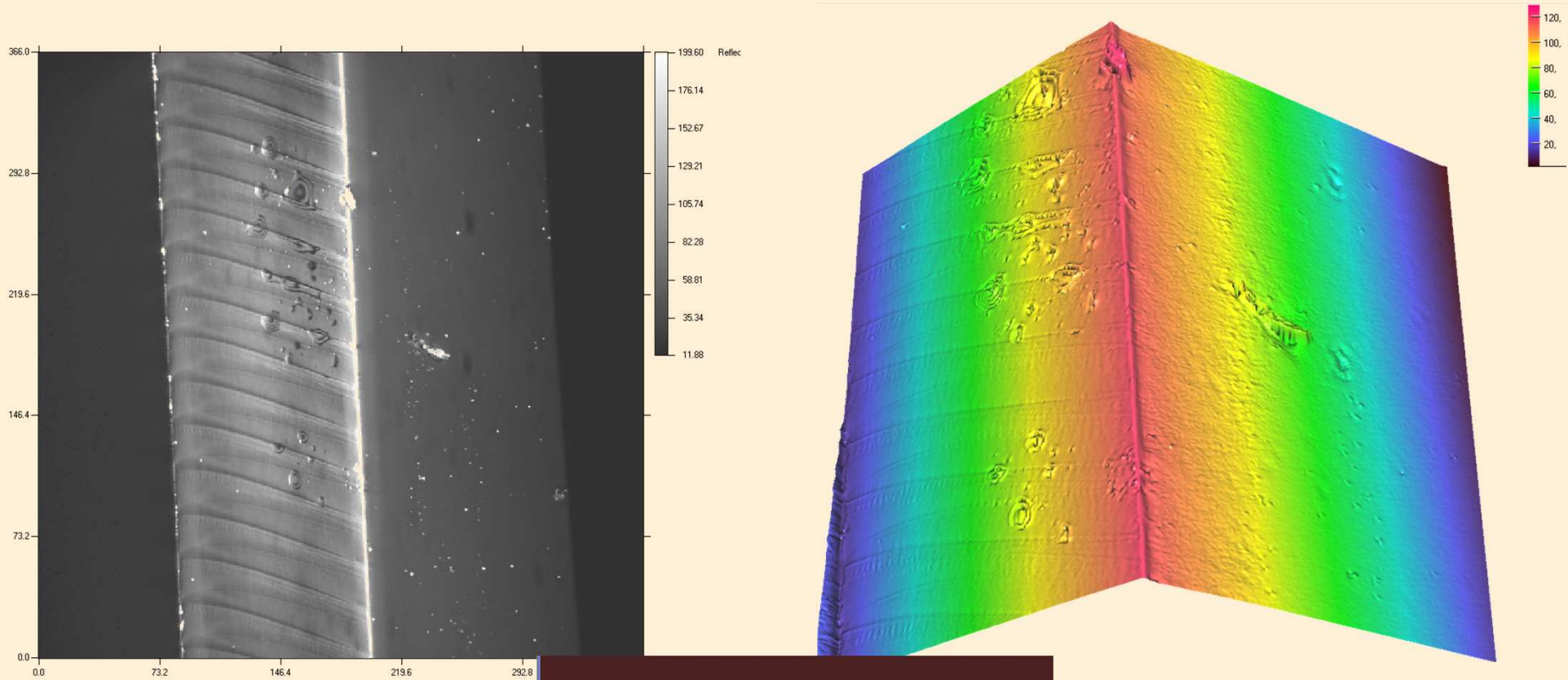
- Groove depth: 8.7 μ m
- Groove width: 28.3 μ m



Wafer Laser Cutting

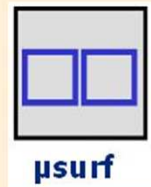
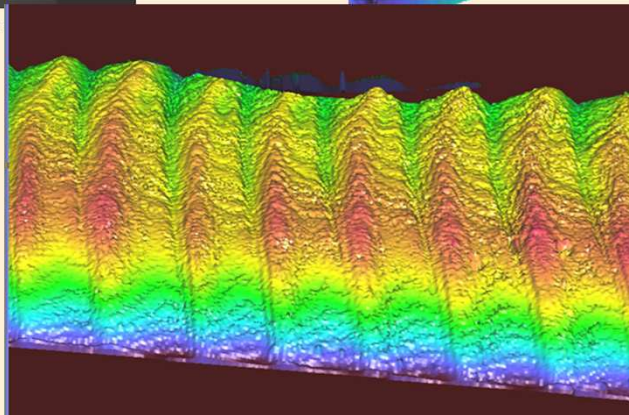


Laser Cutting (thermal stress)

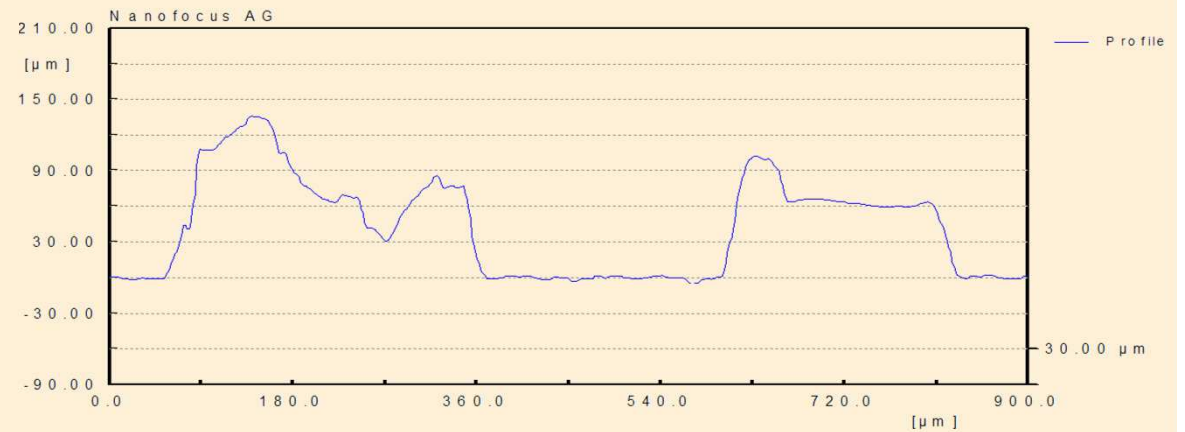
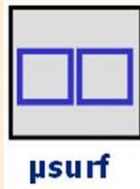
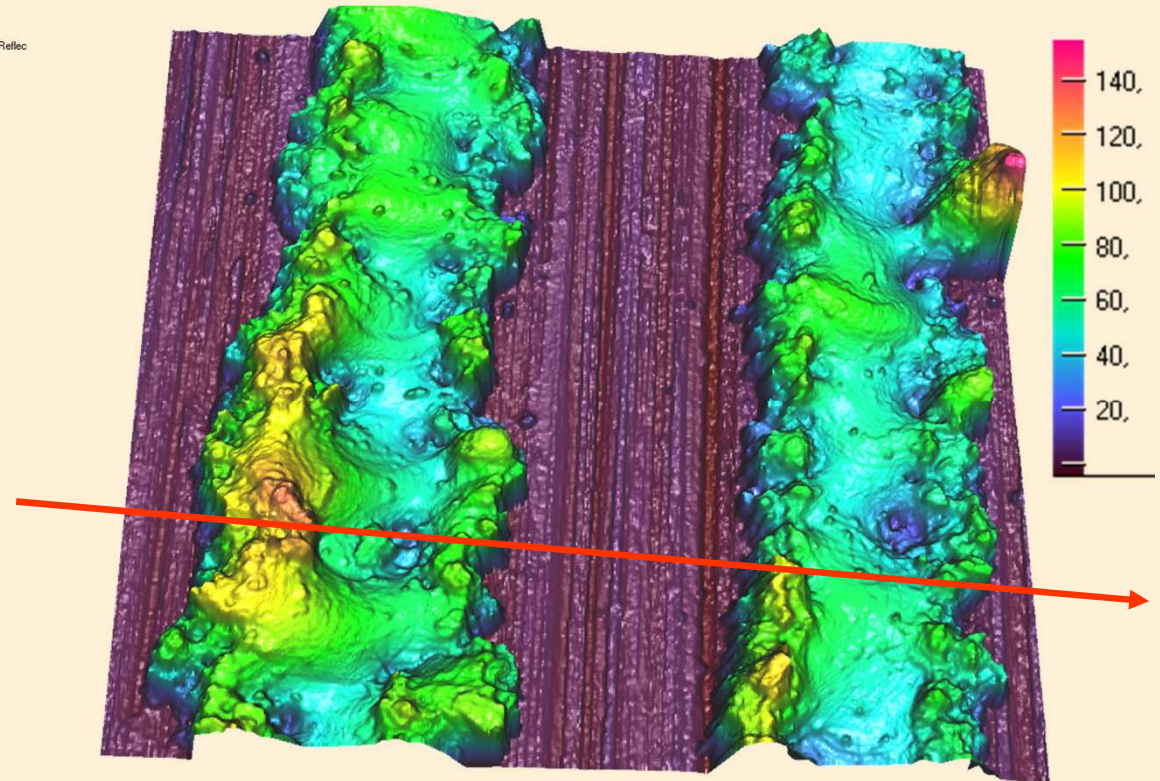
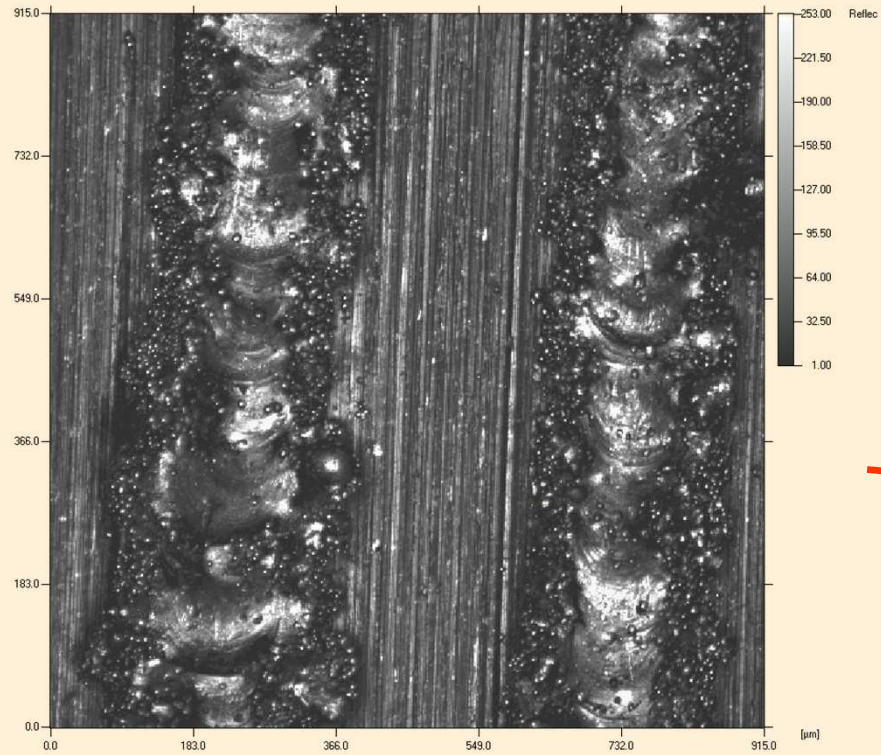


320S

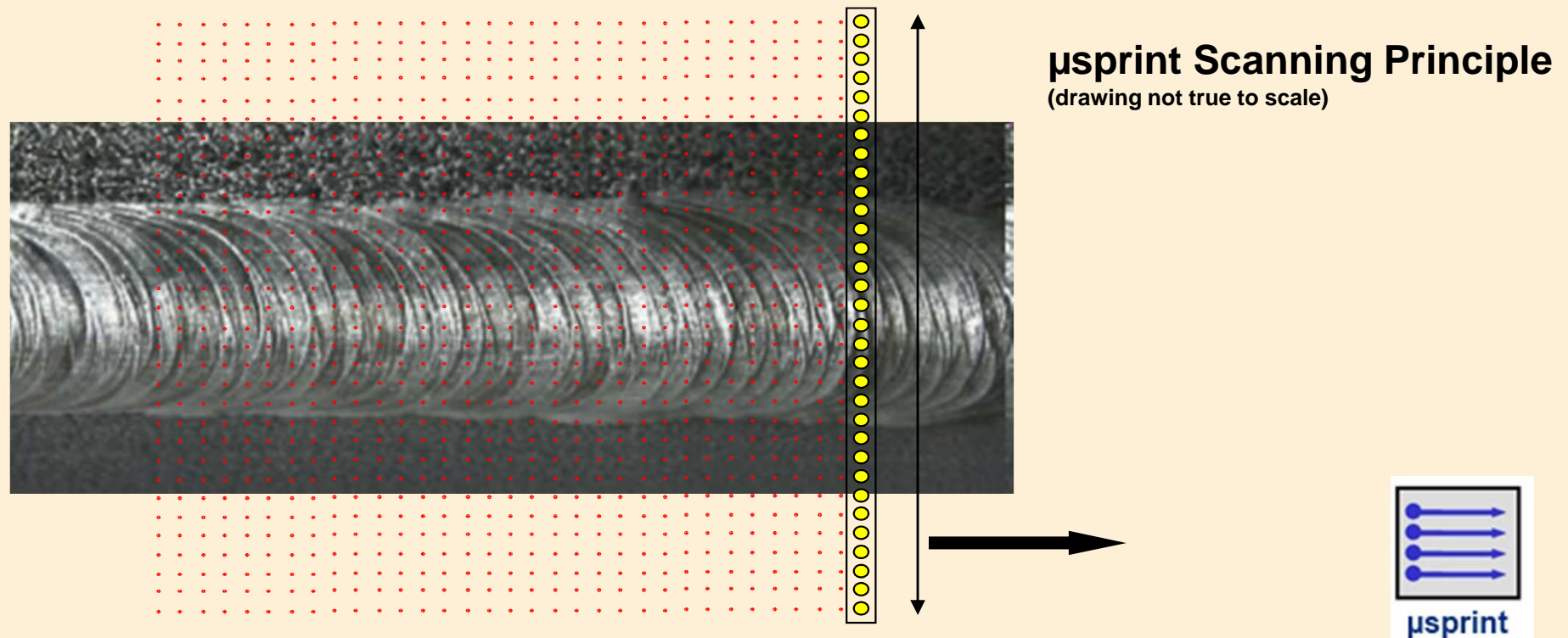
160S



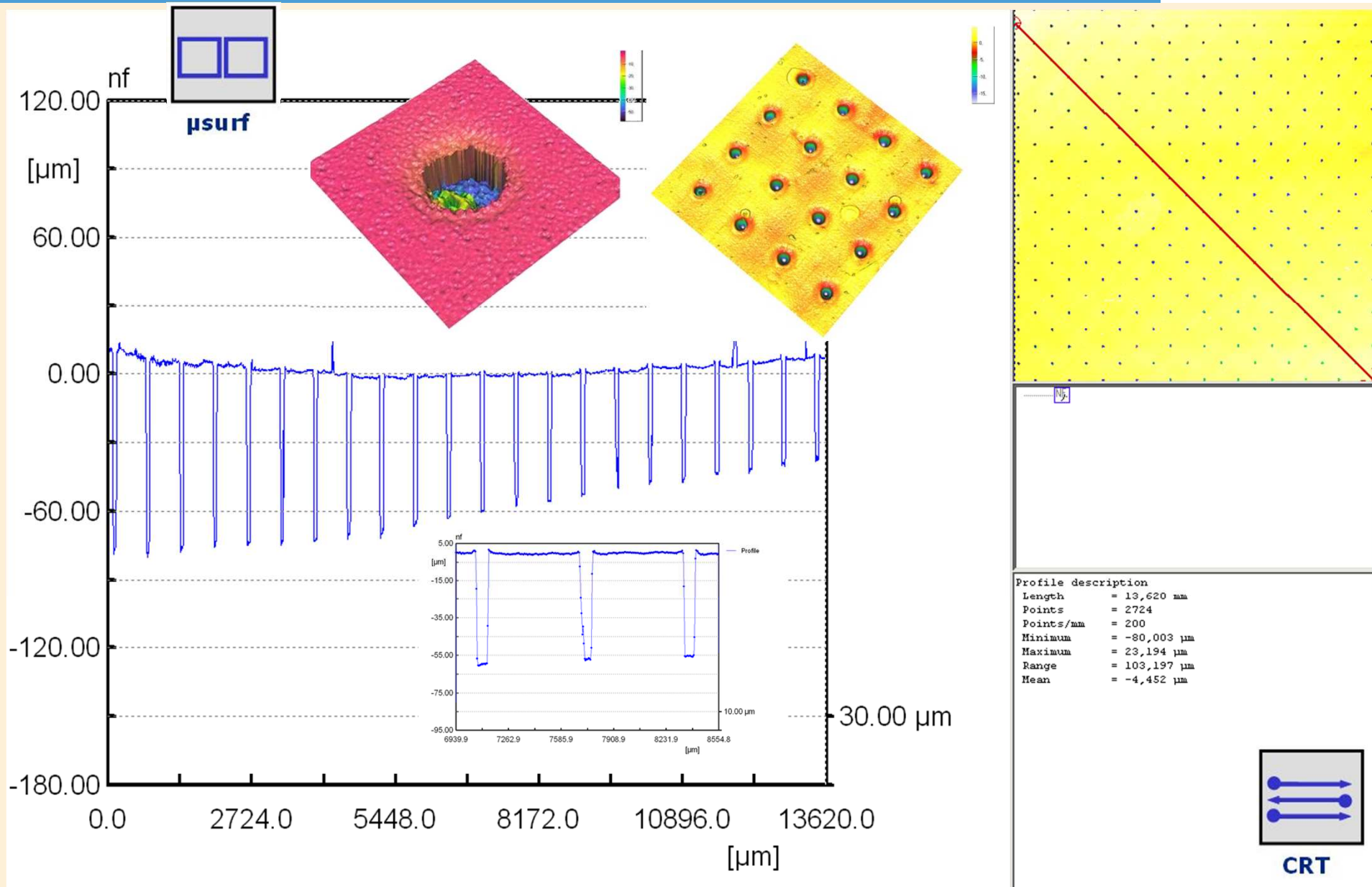
Laser Welding



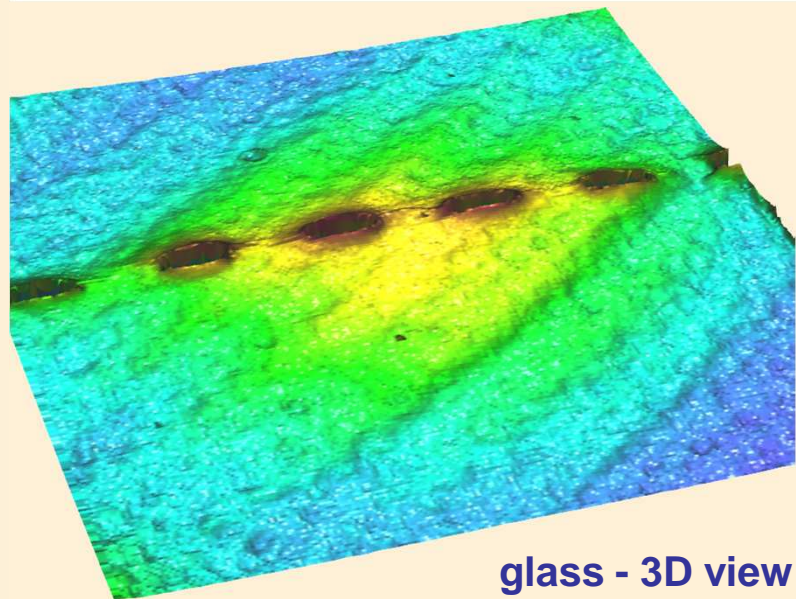
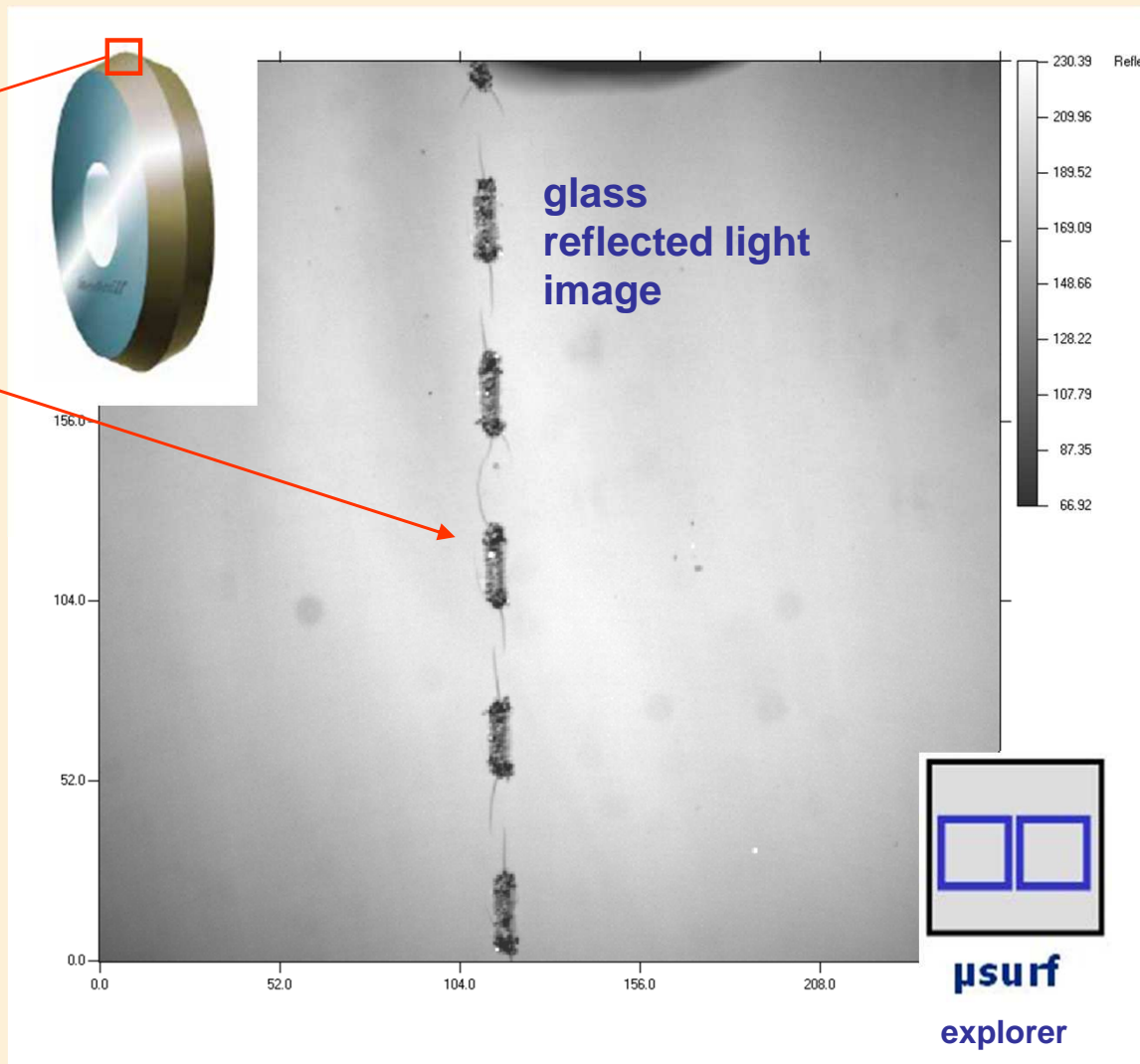
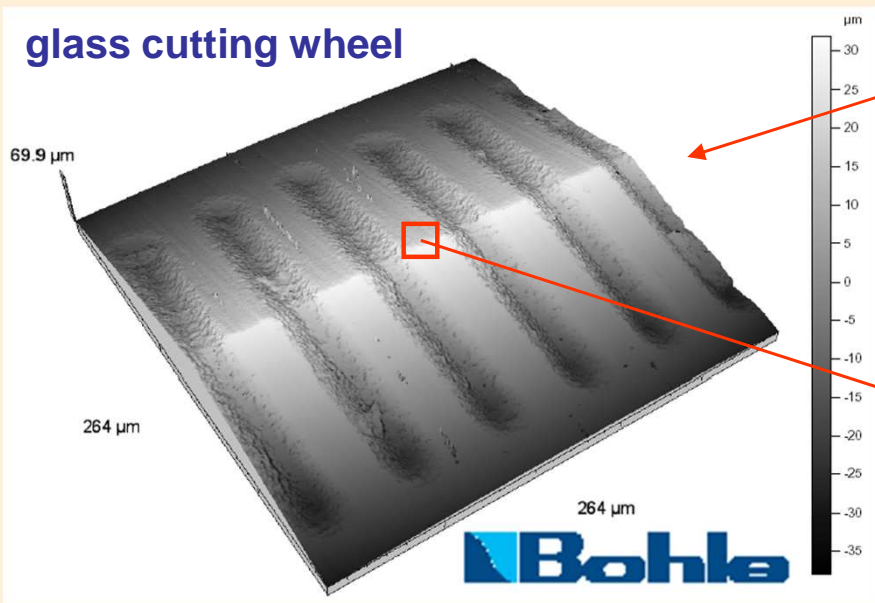
- ▶ 128 parallel channels
- ▶ Standard scanning velocity 54mm/s
- ▶ Measurement spot diameter 1μm

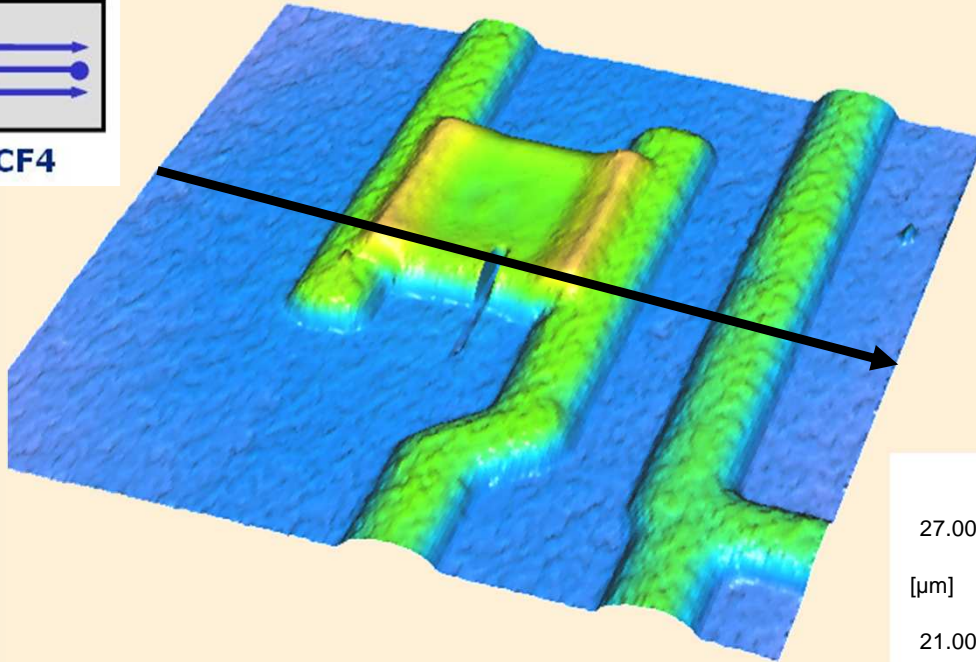
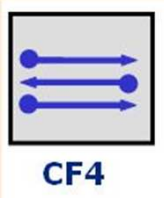


PCB: Laser Drilling Microvias



Laser Machining

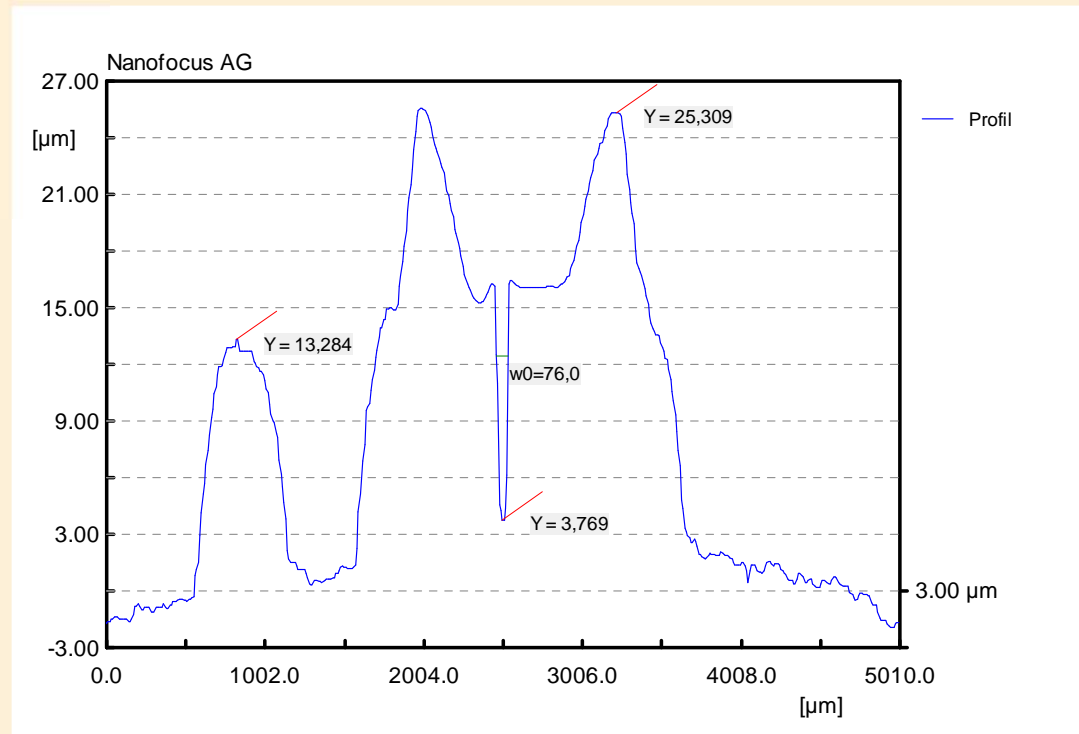




Laser trimming of resistor

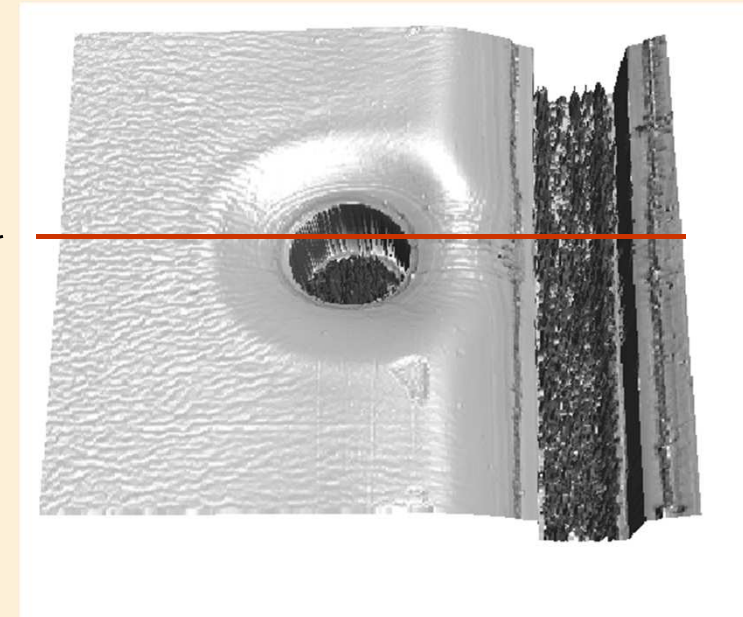
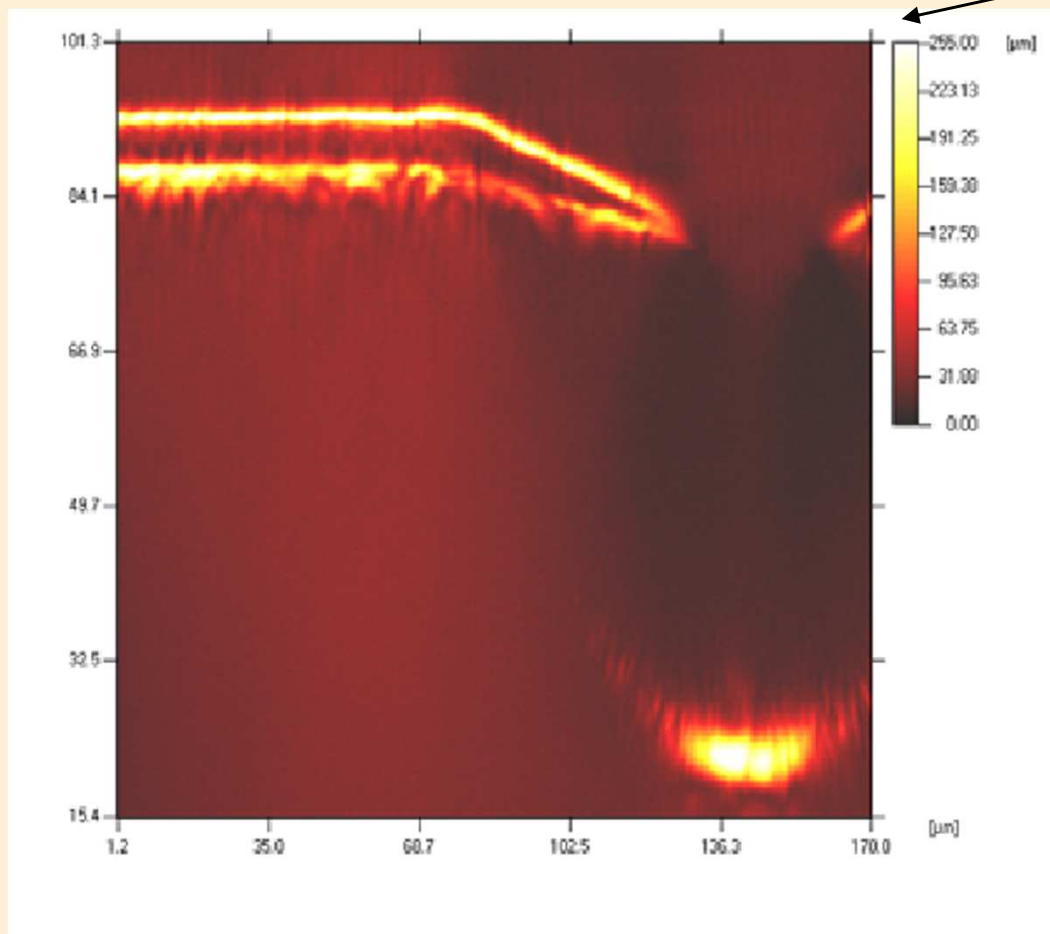
Measurement of thickfilm resistors and conductor lines

- height
- width
- volume



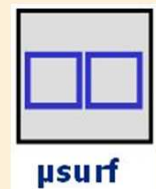
Glass with Coating and Hole

confocal cross section

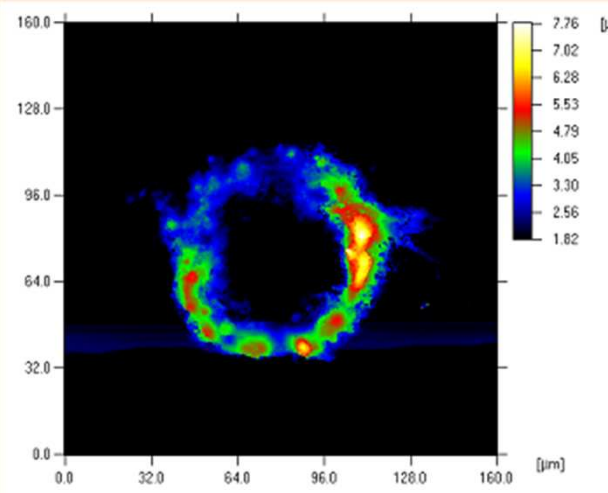
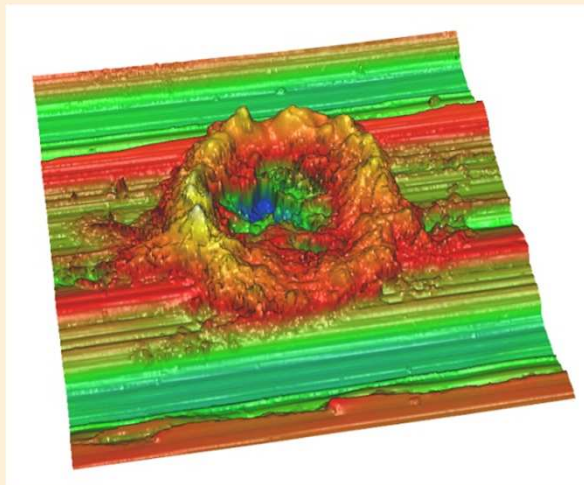


hole in coated glass

- decreasing thickness of coating
- slope around hole
- depth of hole
- surface structure



Laser Texturing of Piston Rod



Piston Rod Inspection (Pleuel)

Laser Texturing of Cylinder Wall

ISO 25178

Höhen-Parameter

Sa	0.877	um
----	-------	----

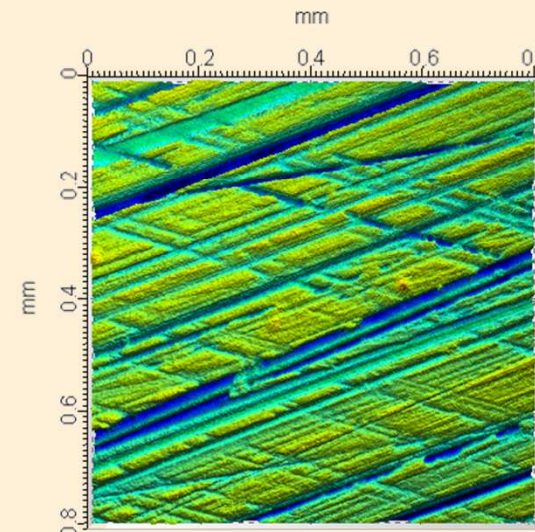
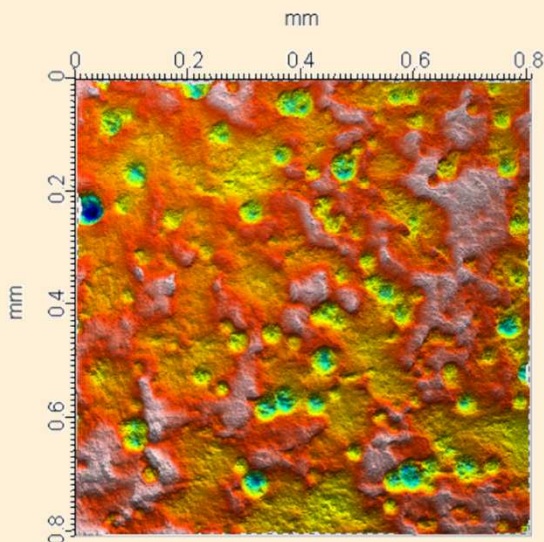
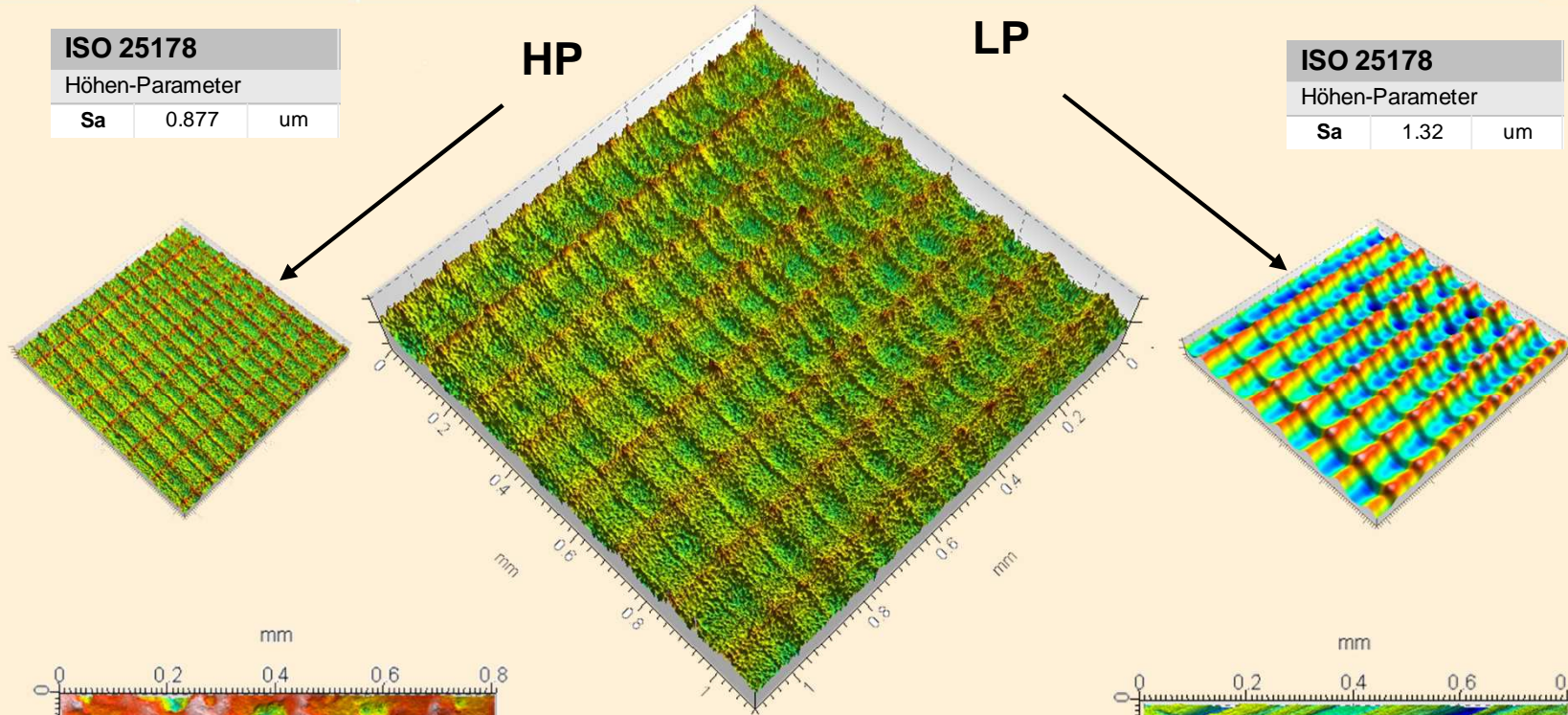
HP

LP

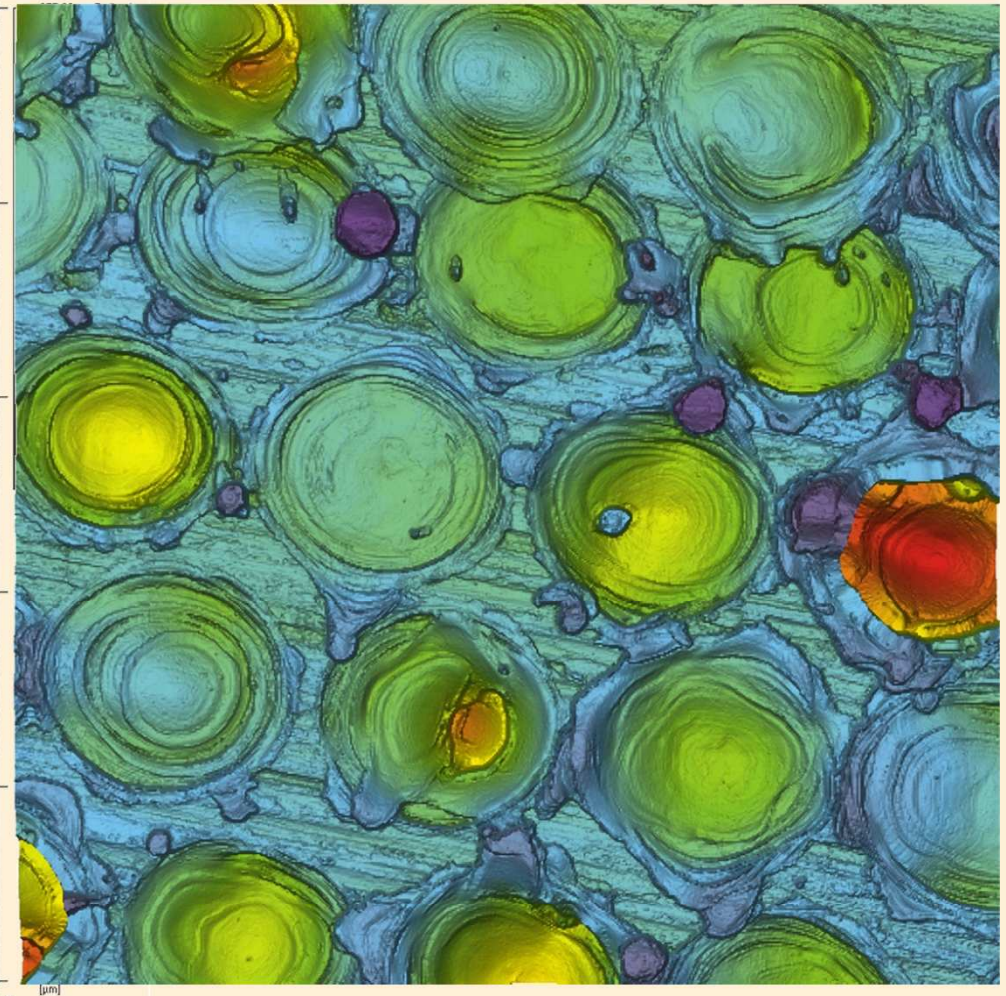
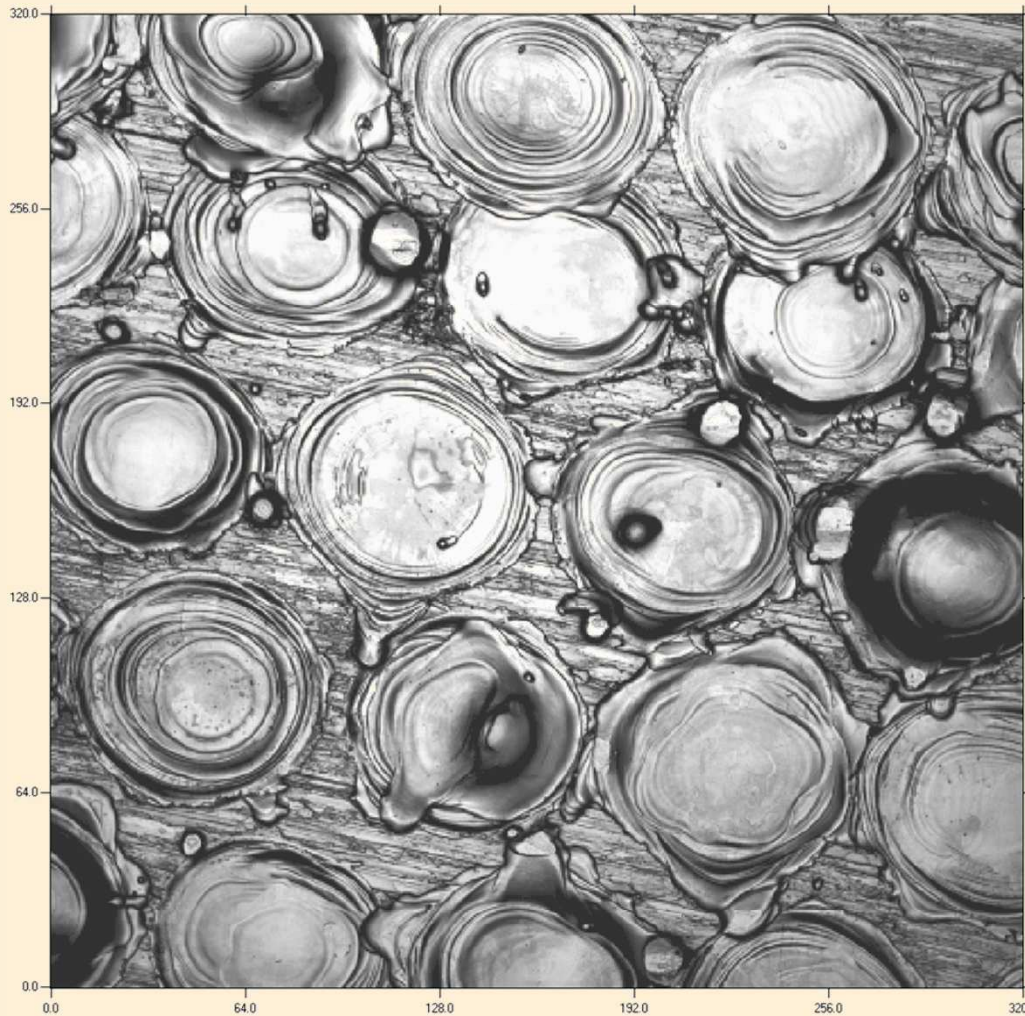
ISO 25178

Höhen-Parameter

Sa	1.32	um
----	------	----



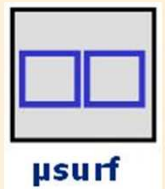
Laser Textured Surface



Intensity

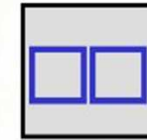
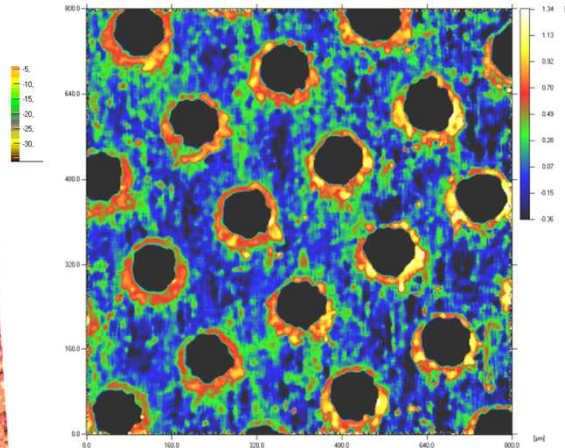
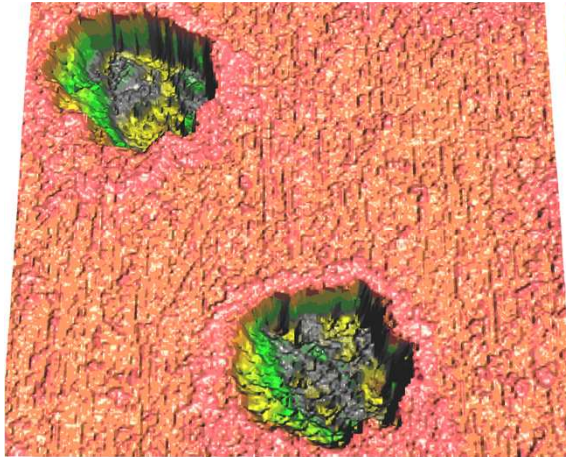
Topography

blood pump tube



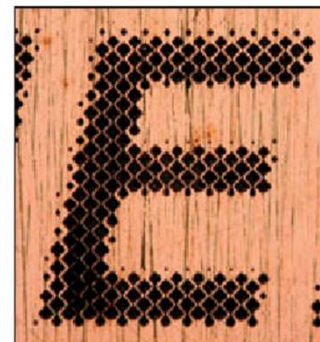
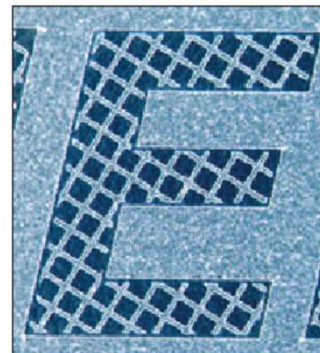
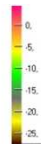
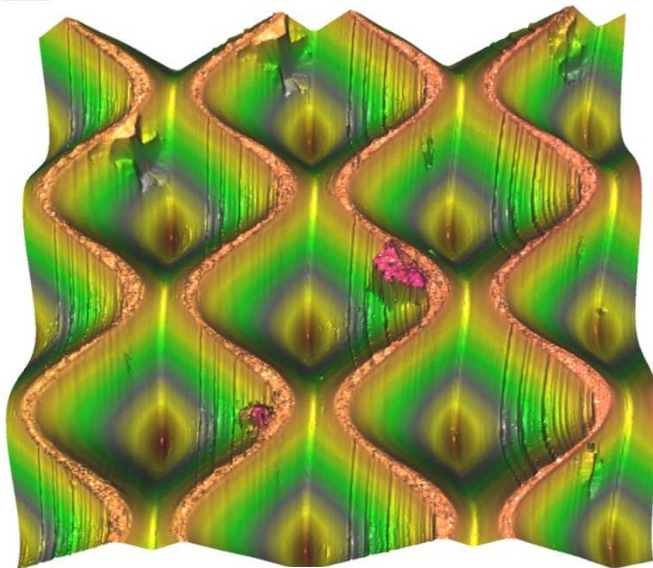
Printing Cylinder

Laser (800S, Zoom)



μsurf

Register

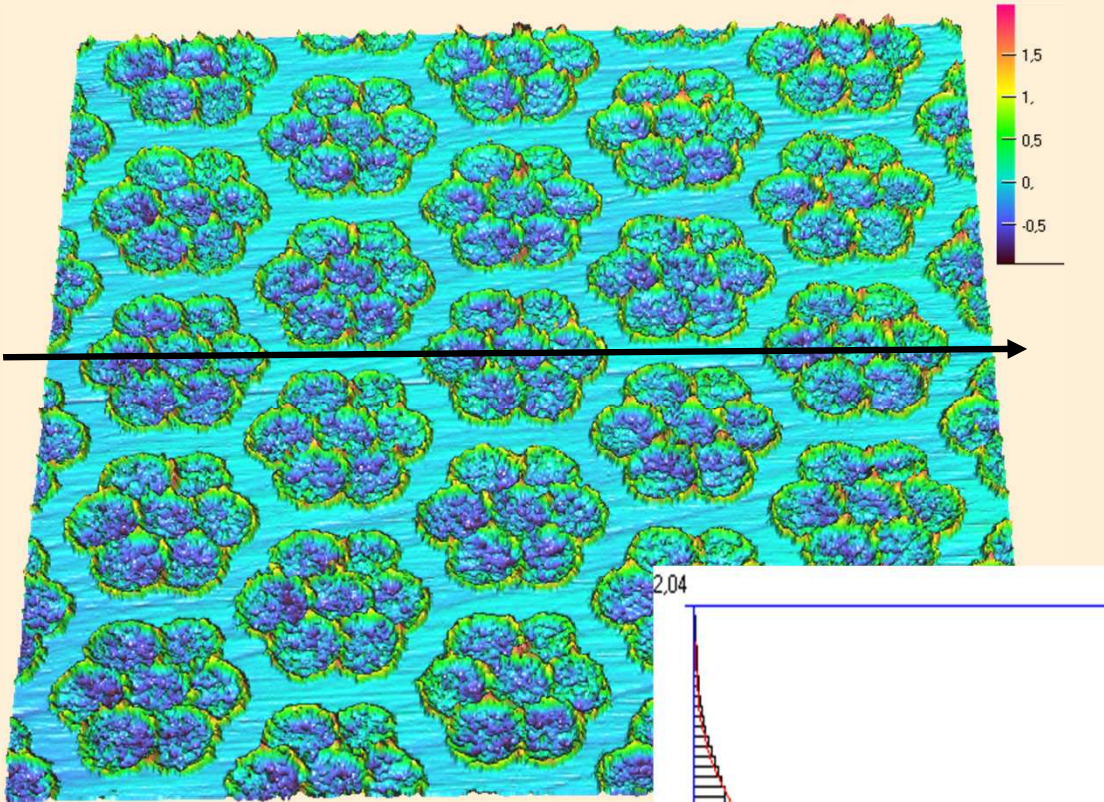


Stylus (320S)



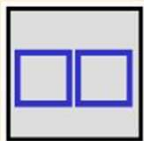
Gravure – Multiple Shot

Master Screen 10% (Zinc)

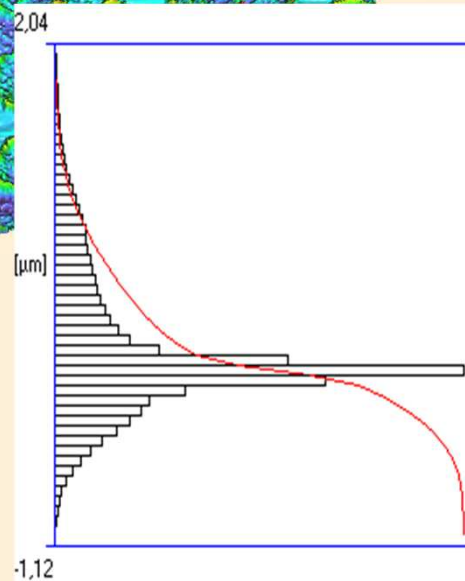


800S

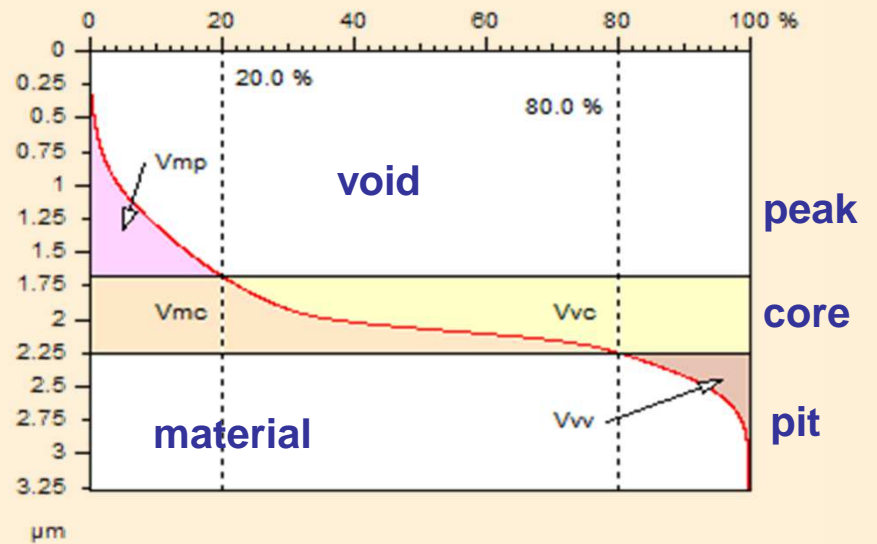
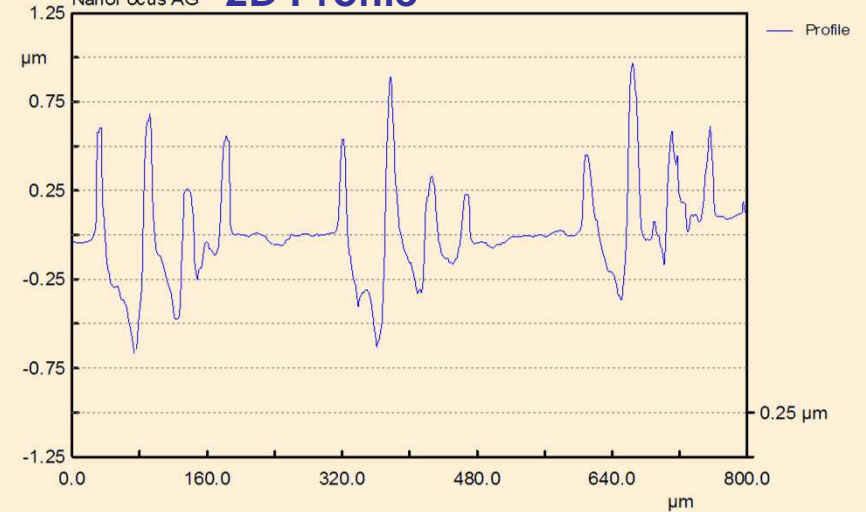
Sa=0,304µm



µsurf



NanoFocus AG 2D Profile

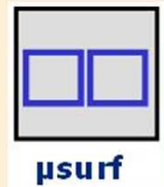
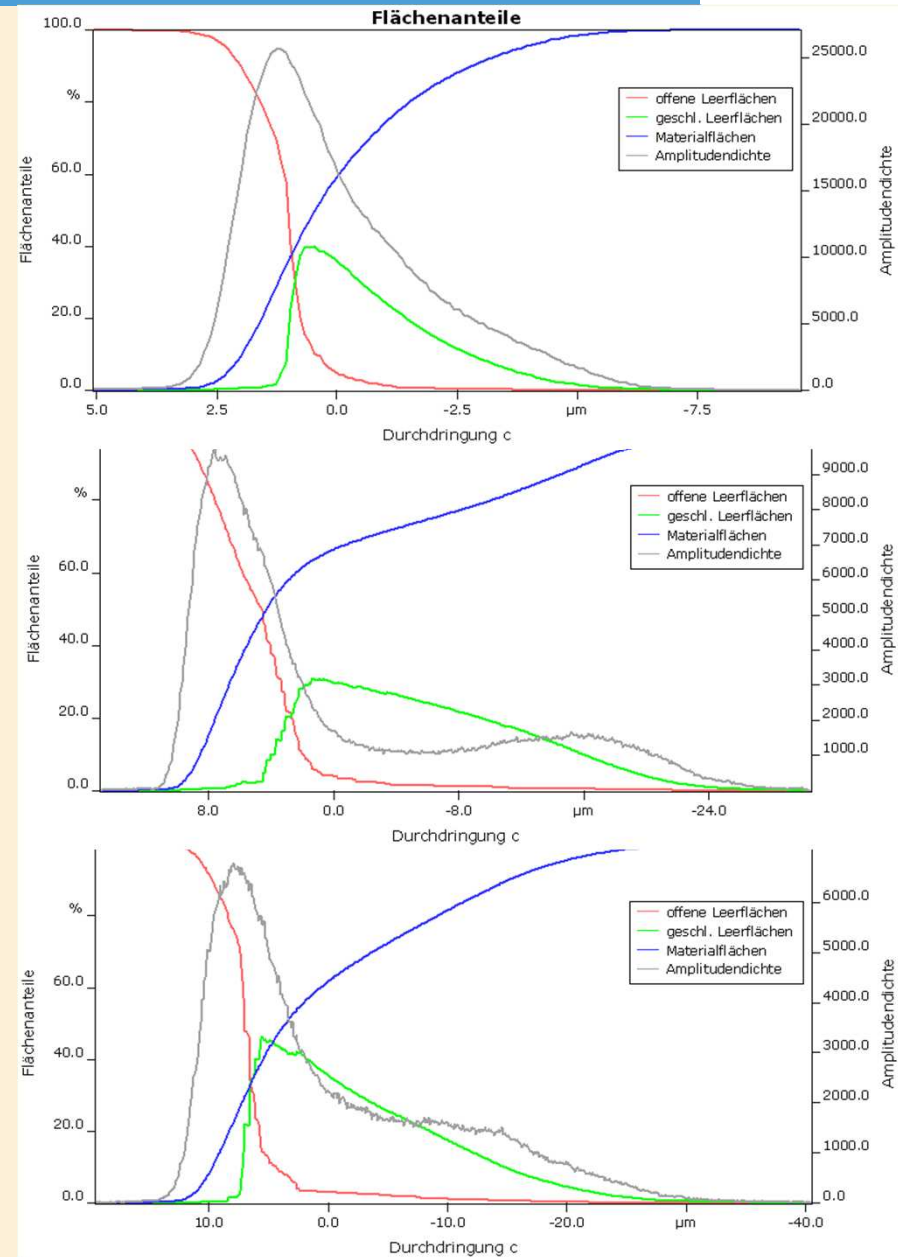
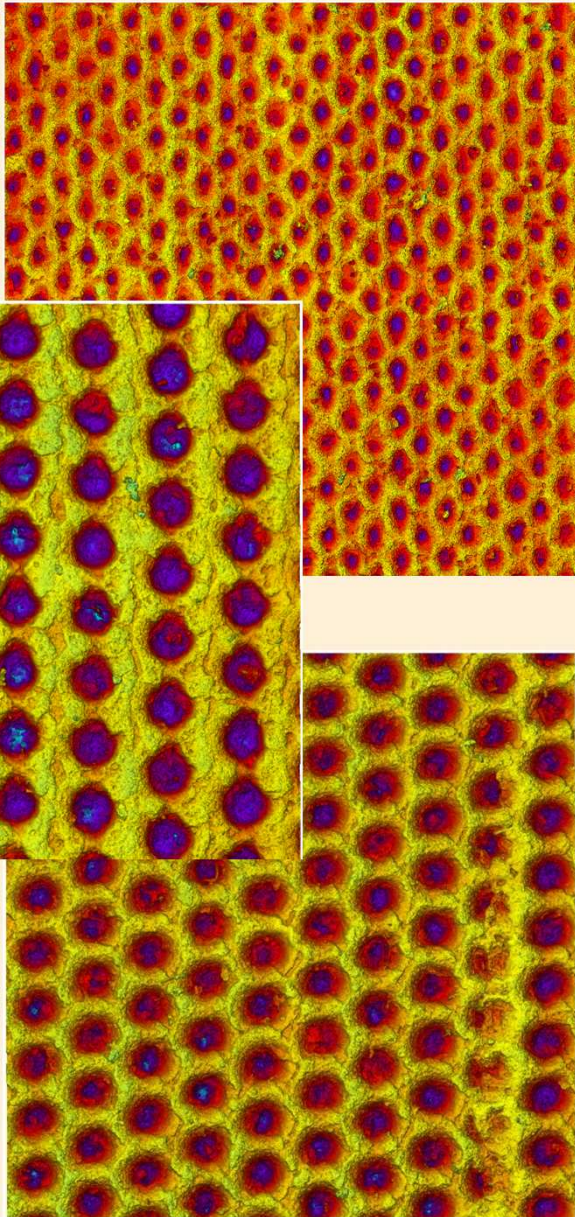


Vmp = 0.0888 ml/m²
Vvc = 0.337 ml/m²

Vmc = 0.237 ml/m²
Vvw = 0.0417 ml/m²

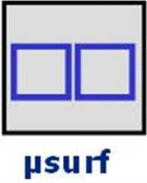
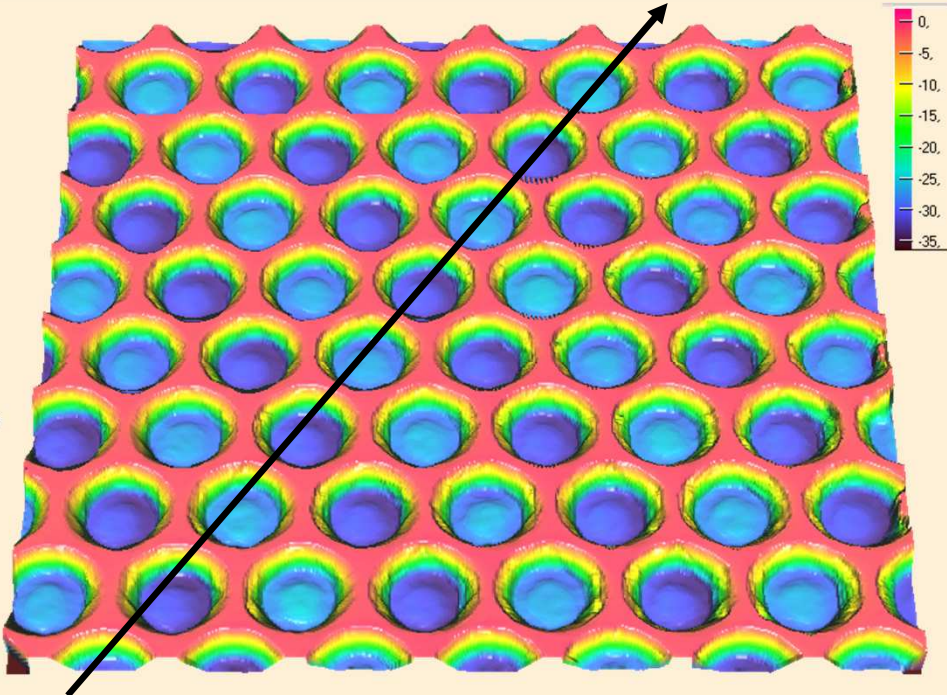
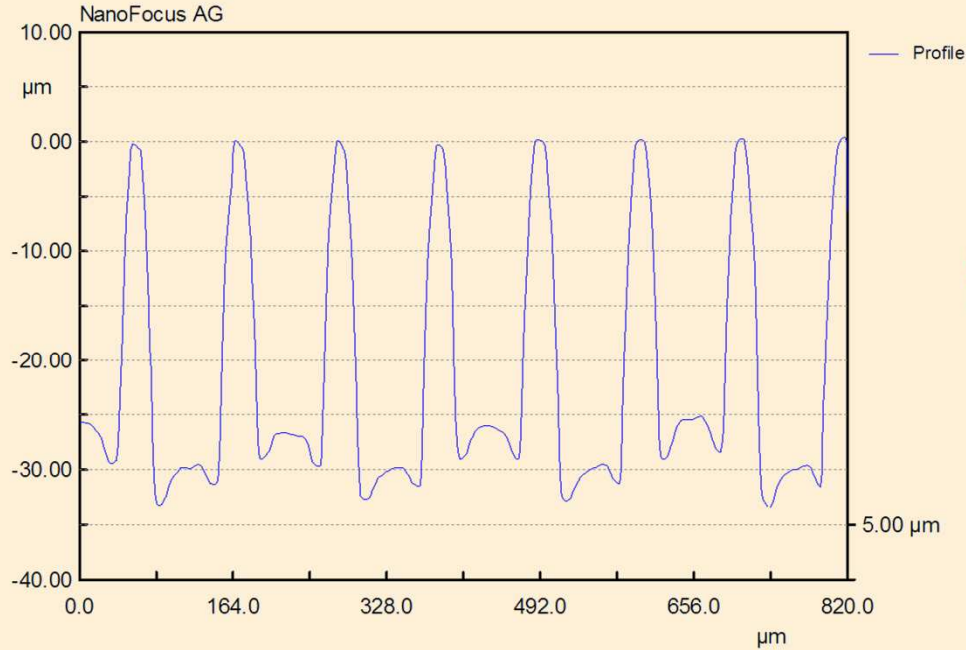
Gravure - Single Shot

ceramics
800S, 2x2:
1.5 x 1.5 mm²



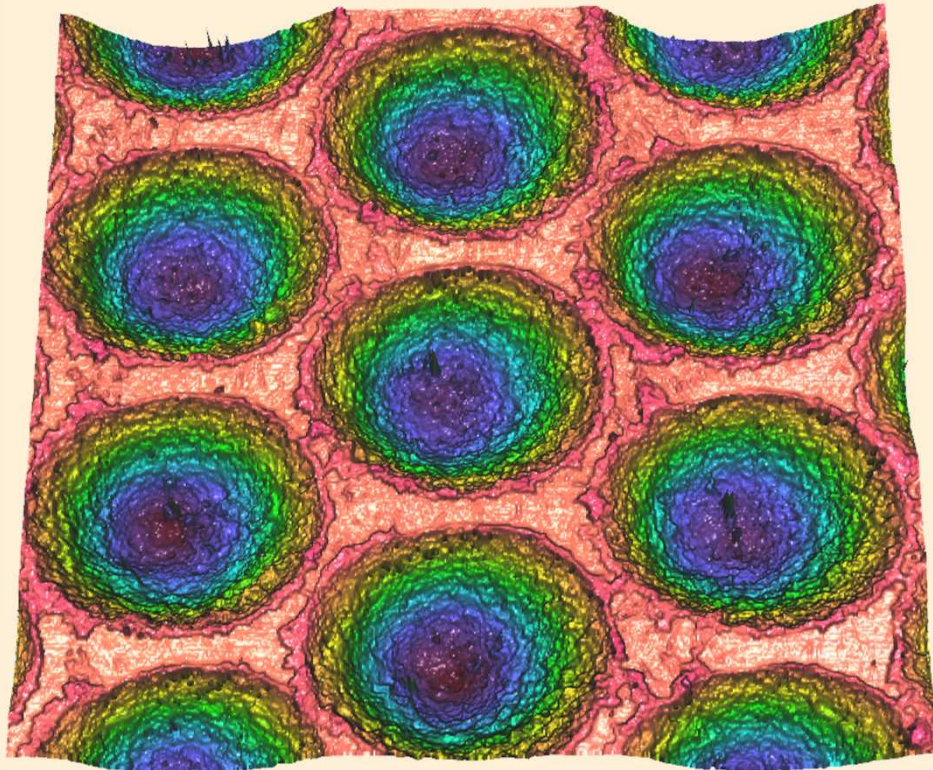
Two laser Single Shot

800S – Laser single shot

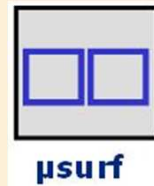


Gravure on Printing Roll

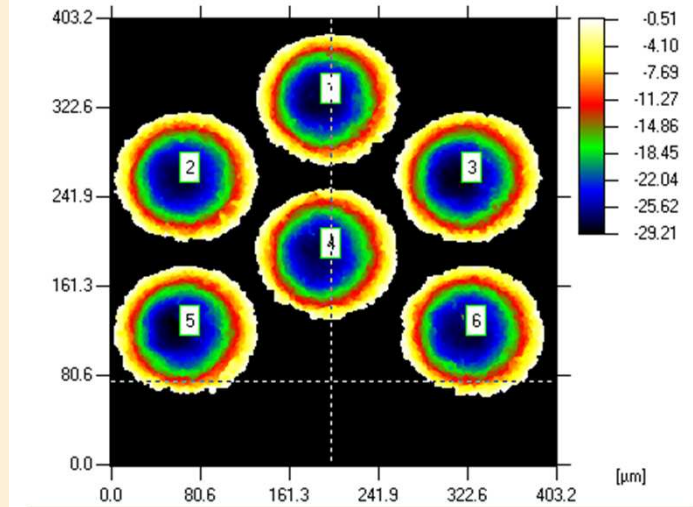
Laser Gravure 320S



1. Measurement

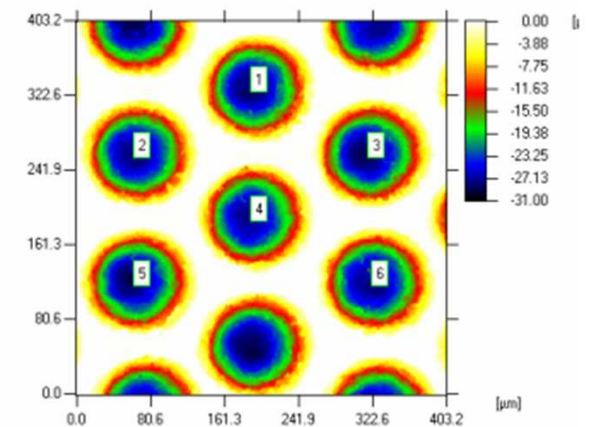


2. Segmentation

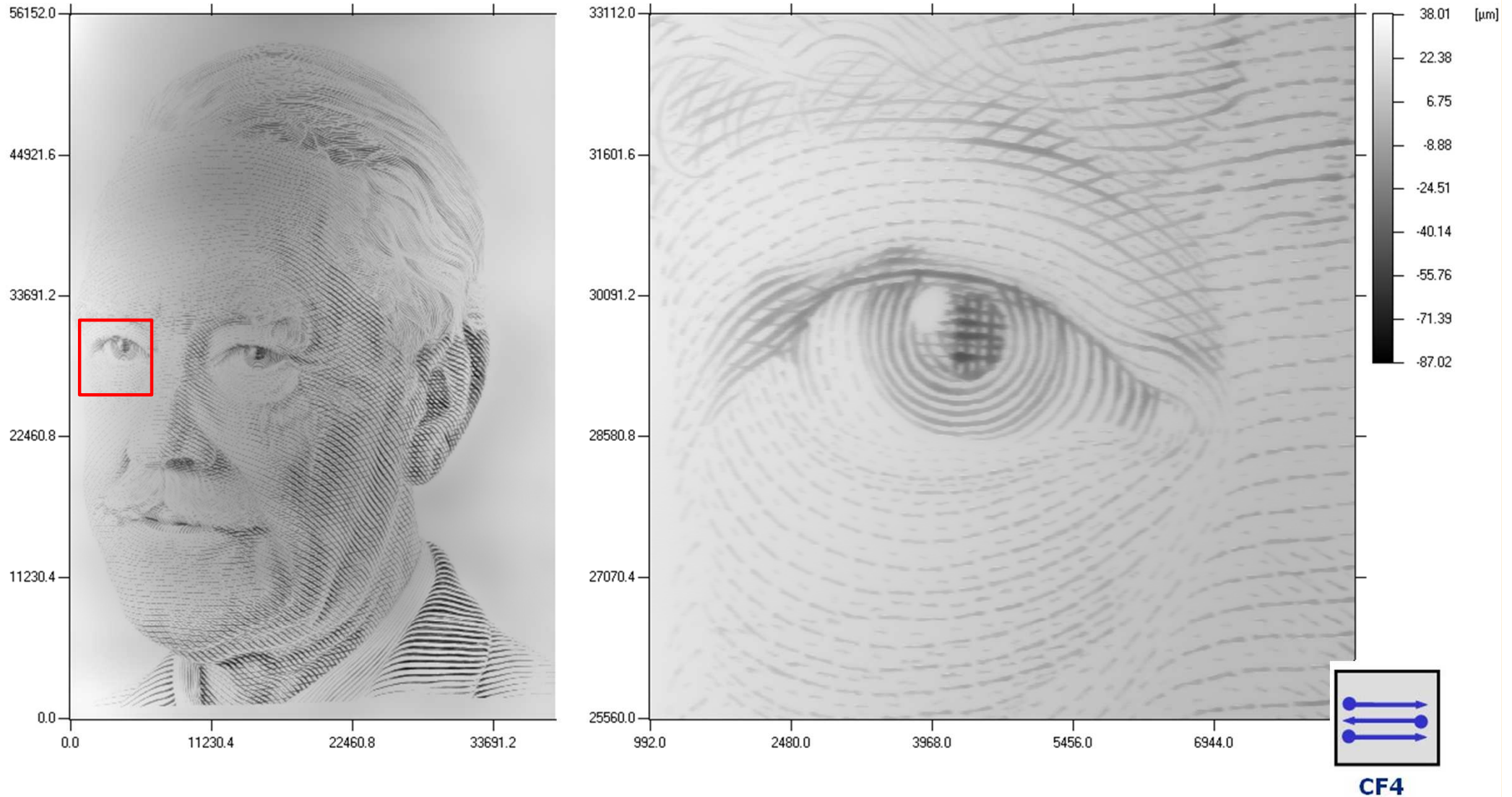


3. Report Sheet

Raster	74,94				
Fläche	11944,1	μm^2			
Tiefe	28,60	μm			
Volumen	9,59	ml/m^2			
Breite	130,47	μm	Länge	117,58	μm



µscan CF: Printing Plate



A scanning electron microscope (SEM) image of a microchip. The chip is dark with a grid of small, bright, circular features. A larger, more complex structure is visible on the right side. The background is a soft, out-of-focus green and blue.

nanofocus[®]
see more 

at booth D4

Thank you for your attention!